Compal Confidential

Lotus M/B Schematics Document

14": Elise; 15.6" Exige

Intel Ivy Bridge ULV Processor with DDRIII + Panther Point

Date : 2011/10/27
Version 0.1

Security Classification	Compal Secret Data		
Issued Date	2011/06/29	Deciphered Date	2011/06/29

Compal Electronics, Inc.			
Title: Block Diagrams			
Size: Custom	Document Number: LA-8551P		Rev: 0.1
Date: Friday, March 02, 2012	Sheet 1 of 55		

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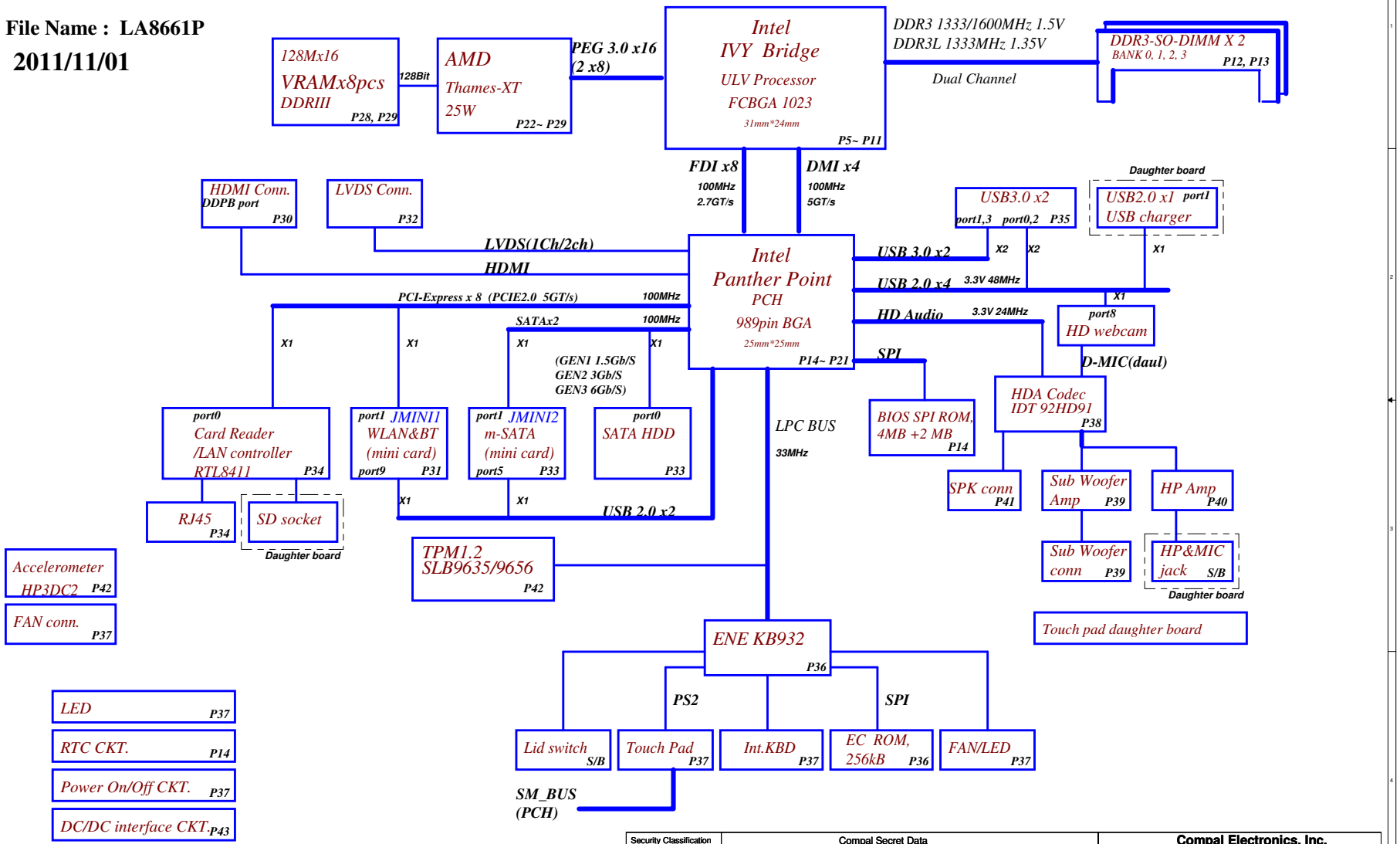
Model Name : Lotus

File Name : LA8661P

2011/11/01



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Title: Block Diagrams

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Custom	LA-8551P	0.1

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QAU30/50 (LA-8661P Ver:0.1)

Voltage Rails

Power Plane	Description	S1	S3	S5
VIN	Adapter power supply (19V)	N/A	N/A	N/A
BATT+	Battery power supply (12.6V)	N/A	N/A	N/A
B+	AC or battery power rail for power circuit.	N/A	N/A	N/A
+CPU_CORE	Core voltage for CPU	ON	OFF	OFF
		ON	OFF	OFF
+VGFX_CORE	Core voltage for UMA graphic	ON	OFF	OFF
+0.75VS	+0.75VP to +0.75VS switched power rail for DDR terminator	ON	OFF	OFF
+1.05VS_VCCP	+V1.05SP to +1.05VS_VCCP switched power rail for CPU	ON	OFF	OFF
+VCCP	+VCCP (1.05V) power for PCH	ON	OFF	OFF
+1.5V	+1.5VP to +1.5V power rail for DDRIII (1.35V OR 1.5V)	ON	ON	OFF
+1.5VS	+1.5VS switched power rail	ON	OFF	OFF
+1.8VS	(+5VALW) to 1.8V switched power rail to PCH	ON	OFF	OFF
+3VALW	+3VALW always on power rail	ON	ON	ON*
+3VALW_EC	+3VALW always to KBC	ON	ON	ON*
+LAN_IO	+3VALW to +LAN_IO power rail for LAN	ON	ON	ON*
+3V_PCH	+3VALW to +3V_PCH power rail for PCH (Short Jumper)	ON	ON	ON*
+3VS	+3VALW to +3VS power rail	ON	OFF	OFF
+5VALW	+5VALWP to +5VALW power rail	ON	ON	ON*
+5V_PCH	+5VALW to +5V_PCH power rail for PCH (Short resister)	ON	ON	ON*
+5VS	+5VALW to +5VS switched power rail	ON	OFF	OFF
+VSB	B+ to +VSB always on power rail for sequence control	ON	ON	ON*
+RTCVCC	RTC power	ON	ON	ON

Note : ON* means that this power plane is ON only with AC power available, otherwise it is OFF.

STATE \ SIGNAL	SLP_S1#	SLP_S3#	SLP_S4#	SLP_S5#	+VALW	+V	+VS	Clock
Full ON	HIGH	HIGH	HIGH	HIGH	ON	ON	ON	ON
S1(Power On Suspend)	LOW	HIGH	HIGH	HIGH	ON	ON	ON	LOW
S3 (Suspend to RAM)	LOW	LOW	HIGH	HIGH	ON	ON	OFF	OFF
S4 (Suspend to Disk)	LOW	LOW	LOW	HIGH	ON	OFF	OFF	OFF
S5 (Soft OFF)	LOW	LOW	LOW	LOW	ON	OFF	OFF	OFF

Power Plane	Description	S1	S3	S5
+VGA_CORE	GPU power	PX	OFF	OFF
+3VGS	GPU power	PX	OFF	OFF
+1.8VGS	GPU power	PX	OFF	OFF
+1.5VGS	GPU power	PX	OFF	OFF
+1.0VGS	GPU power	PX	OFF	OFF

EC SM Bus1 address

Device	Address
Smart Battery	
G-sensor	0x50/0x52

PCH SM Bus address

Device	Address
DDR DIMM0	
DDR DIMM1	
Mini Card1	
Mini Card2	
TP module	

EC SM Bus2 address

Device	Address
PCH (Reserve)	

SMBUS Control Table

	SOURCE	BATT	WLAN MIINI1	BATT Charger	TP	SODIMM	EC_SMB_CK2 EC_SMB_DA2	PCH_SML1CLK PCH_SML1DATA	G-Sensor	GPU	HP AMP
EC_SMB_CK1 EC_SMB_DA1	KB930	V		V					V		
EC_SMB_CK2 EC_SMB_DA2	KB930							V		V	V
PCH_SMBCLK PCH_SMBDATA	PCH		@		V	V					
PCH_SML0CLK PCH_SML0DATA	PCH										
PCH_SML1CLK PCH_SML1DATA	PCH						V				

CLKOUT	DESTINATION
PCI0	PCH_LPBACK
PCI1	PCI_LPC
PCI2	None
PCI3	None
PCI4	None

SATA	DESTINATION
SATA0	SATA, JHDD1
SATA1	m-SATA,JMINI2
SATA2	None
SATA3	None
SATA4	None
SATA5	None

USB Port Table

USB 2.0	USB 1.1	Port	3 External USB Port
EHCI1	UHCI0	0	USB2.0 (left Side)
		1	USB2.0 (right Side)
	UHCI1	2	USB2.0 (left Side)
		3	None
	UHCI2	4	None
		5	None
	UHCI3	6	None
		7	None
EHCI2	UHCI4	8	Camera
		9	Mini Card(WLAN& BT)
	UHCI5	10	None
		11	None
	UHCI6	12	None
		13	None

USB 3.0	Port	2 External USB Port
	1	USB3.0 (left Side)
	2	None
	3	USB3.0 (left Side)
	4	None

	DIFFERENTIAL	DESTINATION	FLEX CLOCKS	DESTINATION
CLK	CLKOUT_PCIE0	PCIE LAN CARD READER	CLKOUTFLEX0	None
			CLKOUTFLEX1	None
	CLKOUT_PCIE1	mini WLAN	CLKOUTFLEX2	None
	CLKOUT_PCIE2	None	CLKOUTFLEX3	DGPU_PRSNT#
	CLKOUT_PCIE3	None		
	CLKOUT_PCIE4	None		
	CLKOUT_PCIE5	None		
	CLKOUT_PCIE6	None		
	CLKOUT_PCIE7	None		
	CLKOUT_PEG_B	None		

BY SKU		
TPM	9635@	9656@
CPU	CPUUMA1@ CPUUMA2@ CPUDIS@	
VRAM	X76@ M2G@	H2G@ S2G@

Option	@	CONN@	USB30@	PX@	UMA@	DIS@	THA@
UMA	X	X	V	X	V	X	X
DIS	X	X	V	V	X	V	V

Symbol Note :
: means Digital Ground
: means Analog Ground

Project ID	30UMA@	30DIS@	50UMA@	50DIS@

PCB	LA-8661P	LA-8662P
	PX@	UMA@

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Title: Notes List

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C	LA-8661P	0.1

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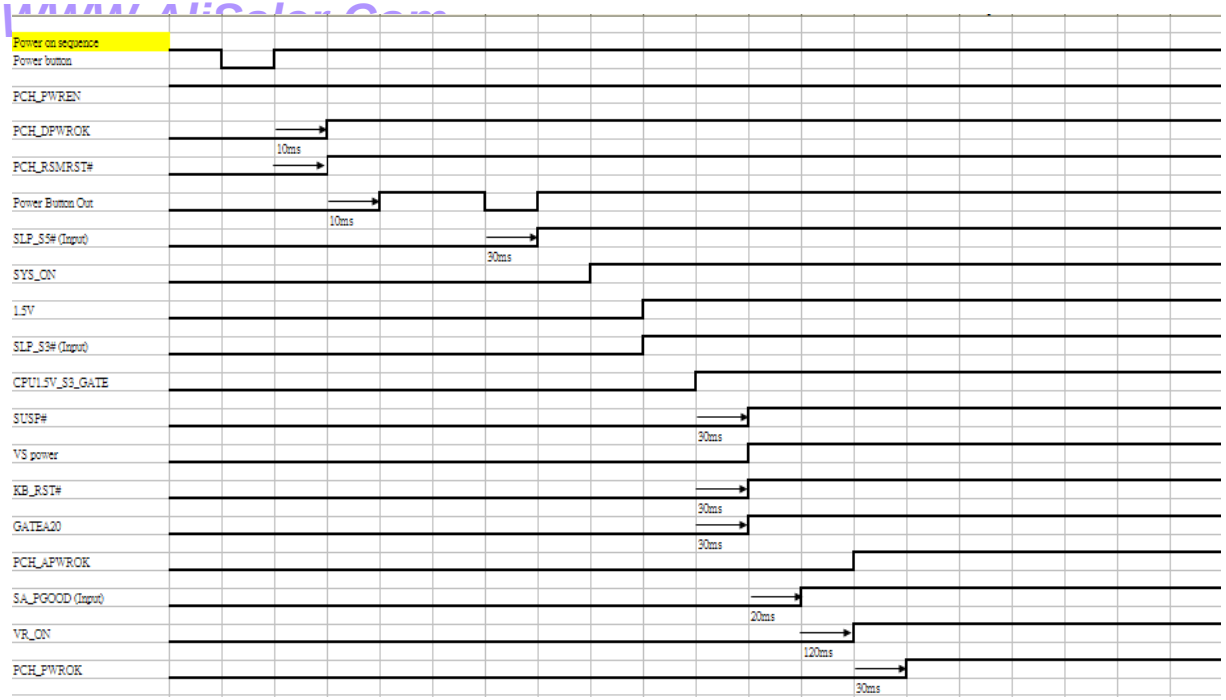

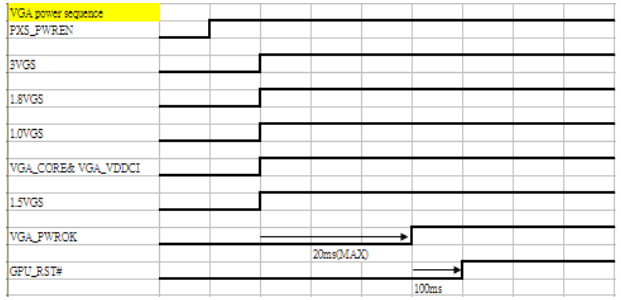

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Title: ***PROCESSOR(1/7) DMI,FDI,PEG***

Size	Document Number	Rev
B		0.1

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UCPU1 CPUDIS01@ i5-2467M CPU SA00004X000

UCPU1 CPUDIS02@ i5-2367M CPU SA00005H20

UCPU1 CPUDIS03@ i5-2367M CPU SA00005H20

UCPU1 CPUDIS04@ i5-3317U CPU SA00005K600

UCPU1 CPUUMA3@ i5-2367M CPU SA00005H20

UCPU1 CPUUMA4@ 17W 1.7GHz GT2 ES2 QBP7 SA00005B010

UCPU1 CPUUMA5@ 17W 1.7GHz no cnfg ES2 QBTQ SA00005B020

UCPU1 CPUUMA1@ 17W 1.5GHz GT2 ES2 QBP8 SA00005AZ10

UCPU1 CPUUMA2@ 17W 1.5GHz no cnfg ES2 QBTP SA00005AZ20

Sandy Bridge:
Intel Core i5-2467M: SA00004X000 (4619HY32L01)

Ivy Bridge:
1.5GHz GT2 ES2 QBP8: SA00005AZ10 (4619HZ32L01)
1.5GHz ES2 QBTP: SA00005AZ20(4619HZ32L02)

PEG_ICOMPI and RCOMPO signals should be shorted and routed with - max length = 500 mils - typical impedance = 43 mohms
PEG_ICOMPO signals should be routed with - max length = 500 mils - typical impedance = 14.5 mohms

UCPU1A @

DMI
- <16> DMI_CRX_PTX_N0 → M2 DMI_RX#[0]
- <16> DMI_CRX_PTX_N1 → P6 DMI_RX#[1]
- <16> DMI_CRX_PTX_N2 → P1 DMI_RX#[2]
- <16> DMI_CRX_PTX_N3 → P10 DMI_RX#[3]
- <16> DMI_CRX_PTX_P0 → N3 DMI_RX[0]
- <16> DMI_CRX_PTX_P1 → P7 DMI_RX[1]
- <16> DMI_CRX_PTX_P2 → P3 DMI_RX[2]
- <16> DMI_CRX_PTX_P3 → P11 DMI_RX[3]
- <16> DMI_CTX_PRX_N0 → K1 DMI_TX#[0]
- <16> DMI_CTX_PRX_N1 → M8 DMI_TX#[1]
- <16> DMI_CTX_PRX_N2 → N4 DMI_TX#[2]
- <16> DMI_CTX_PRX_N3 → R2 DMI_TX#[3]
- <16> DMI_CTX_PRX_P0 → K3 DMI_TX[0]
- <16> DMI_CTX_PRX_P1 → M7 DMI_TX[1]
- <16> DMI_CTX_PRX_P2 → P4 DMI_TX[2]
- <16> DMI_CTX_PRX_P3 → T3 DMI_TX[3]

FDI
- <16> FDI_CTX_PRX_N0 → U7 FDI0_TX#[0]
- <16> FDI_CTX_PRX_N1 → W11 FDI0_TX#[1]
- <16> FDI_CTX_PRX_N2 → W1 FDI0_TX#[2]
- <16> FDI_CTX_PRX_N3 → AA6 FDI0_TX#[3]
- <16> FDI_CTX_PRX_N4 → W6 FDI1_TX#[0]
- <16> FDI_CTX_PRX_N5 → V4 FDI1_TX#[1]
- <16> FDI_CTX_PRX_N6 → Y2 FDI1_TX#[2]
- <16> FDI_CTX_PRX_N7 → AC9 FDI1_TX#[3]
- <16> FDI_CTX_PRX_P0 → U6 FDI0_TX[0]
- <16> FDI_CTX_PRX_P1 → W10 FDI0_TX[1]
- <16> FDI_CTX_PRX_P2 → W3 FDI0_TX[2]
- <16> FDI_CTX_PRX_P3 → AA7 FDI0_TX[3]
- <16> FDI_CTX_PRX_P4 → W7 FDI1_TX[0]
- <16> FDI_CTX_PRX_P5 → T4 FDI1_TX[1]
- <16> FDI_CTX_PRX_P6 → AA3 FDI1_TX[2]
- <16> FDI_CTX_PRX_P7 → AC8 FDI1_TX[3]
- <16> FDI_FSYNC0 → AA11 FDI0_FSYNC
- <16> FDI_FSYNC1 → AC12 FDI1_FSYNC
- <16> FDI_INT → U11 FDI_INT
- <16> FDI_LSYNC0 → AA10 FDI0_LSYNC
- <16> FDI_LSYNC1 → AG8 FDI1_LSYNC

PCI EXPRESS - GRAPHICS
- PEG_ICOMPI → G3
- PEG_ICOMPO → G1
- PEG_RCOMPO → G4
- PEG_COMP
- PEG_RX#[0] → H22
- PEG_RX#[1] → J21
- PEG_RX#[2] → B22
- PEG_RX#[3] → D21
- PEG_RX#[4] → A19
- PEG_RX#[5] → D17
- PEG_RX#[6] → B14
- PEG_RX#[7] → D13
- PEG_RX#[8] → A11
- PEG_RX#[9] → B10
- PEG_RX#[10] → G8
- PEG_RX#[11] → A8
- PEG_RX#[12] → B6
- PEG_RX#[13] → H8
- PEG_RX#[14] → E5
- PEG_RX#[15] → K7
- PEG_RX[0] → K22
- PEG_RX[1] → K19
- PEG_RX[2] → C21
- PEG_RX[3] → D19
- PEG_RX[4] → C19
- PEG_RX[5] → D16
- PEG_RX[6] → C13
- PEG_RX[7] → D12
- PEG_RX[8] → C11
- PEG_RX[9] → C9
- PEG_RX[10] → F8
- PEG_RX[11] → C8
- PEG_RX[12] → C5
- PEG_RX[13] → H6
- PEG_RX[14] → F6
- PEG_RX[15] → K6
- PEG_TX#[0] → G22
- PEG_TX#[1] → C23
- PEG_TX#[2] → D23
- PEG_TX#[3] → F21
- PEG_TX#[4] → H19
- PEG_TX#[5] → C17
- PEG_TX#[6] → K15
- PEG_TX#[7] → F17
- PEG_TX#[8] → F14
- PEG_TX#[9] → A15
- PEG_TX#[10] → J14
- PEG_TX#[11] → H13
- PEG_TX#[12] → M10
- PEG_TX#[13] → F10
- PEG_TX#[14] → D9
- PEG_TX#[15] → J4
- PEG_TX[0] → F22
- PEG_TX[1] → A23
- PEG_TX[2] → D24
- PEG_TX[3] → F21
- PEG_TX[4] → G19
- PEG_TX[5] → B18
- PEG_TX[6] → K17
- PEG_TX[7] → G17
- PEG_TX[8] → E14
- PEG_TX[9] → C15
- PEG_TX[10] → K13
- PEG_TX[11] → G13
- PEG_TX[12] → K10
- PEG_TX[13] → G10
- PEG_TX[14] → D8
- PEG_TX[15] → K4

eDP
- eDP_COMPIO → AF3
- eDP_ICOMPO → AD2
- eDP_HPD# → AG11
- eDP_AUX# → AG4
- eDP_AUX → AF4
- eDP_TX#[0] → AC3
- eDP_TX#[1] → AC4
- eDP_TX#[2] → AE11
- eDP_TX#[3] → AE7
- eDP_TX[0] → AC1
- eDP_TX[1] → AA4
- eDP_TX[2] → AE10
- eDP_TX[3] → AE6

IVY-BRIDGE_BGA1023

+VCCP

RC1 24.9_0402_1% (PEG_COMP)

CU65 0.1U_0402_16V4Z

Add CU65 0.1U as EMI request.
12.19

<PEG>

<PEG>

+VCCP

RC88@ 10K_0402_5%

RC2 24.9_0402_1% (EDP_COMP)

eDP_COMPIO and ICOMPO signals should be shorted near balls and routed with typical impedance <25 mohms

NOTE:eDP_COMPIO and eDP_ICOMPO should not be left floating even if Internal Graphic is disabled since they are shared with other interfaces

10/05 Change to 0.22uF.

Typ- suggest 220nF. The change in AC capacitor value from 180nF to 265nF is to enable compatibility with future platforms having PCIE Gen3 (8GT/s)

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Buffered reset to CPU

Reset# signal is driven by the PCH to multiple agents on the platform.
PCH Reset# output DC levels are 0-V and 3.3 V.
processor Reset input DC levels are 0V and 1.0 V.
Processor high-voltage level is lower than PCH high voltage level, therefore a voltage level shifter is required on the Reset# signal.
In order for Reset# to meet the signal quality requirement at the input to the processor OD buffer must be placed on the motherboard between the PCH and the processor.

+3VS, CC1 0.1U_0402_16V4Z, +VCCP, RC3 75_0402_5%, UC1 SN74LVC1G07DCKR_SC70-5, RC4 43_0402_1%, RC6 @ 750_0402_1%, R375 @ 0_0402_5%
<17,22,31,34,36,42> PLT_RST# → BUFO_CPU_RST# → BUF_CPU_RST#

Requires a series resistor of 43±5% between processor and PCH. It also a needs an Rtt of 75±5% to VCCP after the OD buffer and before the series resistor.

UCPU1B @ — IVY-BRIDGE_BGA1023

MISC: PROC_SELECT# (F49), PROC_DETECT# (C57), CATERR# (C49), PECI (A48), PROCHOT# (C45), THERMTRIP# (D45)
CLOCKS: BCLK (J3), BCLK# (H2), DPLL_REF_CLK (AG3), DPLL_REF_CLK# (AG1)
DDR3 MISC: SM_DRAMRST# (AT30), SM_RCOMP[0] (BF44), SM_RCOMP[1] (BE43), SM_RCOMP[2] (BG43)
PWR MANAGEMENT: PRDY# (N53), PREQ# (N55), UNCOREPWRGOOD (B46), SM_DRAMPWROK (BE45), RESET# (D44), PM_SYNC (C48)
JTAG & BPM: TCK (L56), TMS (L55), TRST# (J58), TDI (M60), TDO (L59), DBR# (K58), BPM#[0..7] (G58, E55, E59, G55, G59, H60, J59, J61)

This pin is for compability with future platforms. A pull up resistor to VCCIO is required if connected to the DF_TVS strap on the PCH.

PROC_DETECT (Processor Detect): pulled to ground on the processor package. There is no connection to the processor silicon for this signal. System board designers may use this signal to determine if the processor is present

<18> H_SNB_IVB#
@RC7 10K_0201_5% — SI2 change to 0201 12.19
PAD T5 @

<18,36> H_PECI
<36,46> H_PROCHOT# → H_PROCHOT#_R RC10 56_0402_5%
<18> H_THRMTRIP# → H_THEMTRIP#_R RC12 0_0402_5%

CLK_CPU_DMI <15>, CLK_CPU_DMI# <15> — 100MHz
RC85 1K_0402_5%, RC84 1K_0402_5% → +VCCP

XDP_DBRESET# → RC5 1K_0201_5% → +3VS
SI2 change to 0201 12.19

SM_DRAMRST# → H_DRAMRST# <7>
SM_RCOMP[0] SM_RCOMP0, SM_RCOMP[1] SM_RCOMP1, SM_RCOMP[2] SM_RCOMP2

PAD T35, PAD T39

TCK XDP_TCK, TMS XDP_TMS, TRST# XDP_TRST#, TDI XDP_TDI, TDO XDP_TDO

DBR# K58 → XDP_DBRESET# → RC17 0_0201_5% → XDP_DBRESET# <16>
12/16:Change to 0201 for SI2

BPM#[0..7] → XDP_BPM#0_R .. XDP_BPM#7_R → T60 @PAD, T61 @PAD, T62 @PAD, T63 @PAD

2011.10.18 delete all reserved XDP conponent.
Just reserve test point for XDP.

Processor Pullups

+VCCP
RC8 62_0402_5% H_PROCHOT#
RC11 10K_0201_5% H_CPUPWRGD_R
SI2 change to 0201 12.19

SI2 change to 0201 12.19
<16> H_PM_SYNC → H_PM_SYNC_R RC13 0_0201_5%
<18> H_CPUPWRGD → H_CPUPWRGD_R RC16 0_0201_5%
UNCOREPWRGOOD:非CORE外的電OK
PM_SYS_PWRGD_BUF → PM_DRAM_PWRGD_R RC18 130_0402_5%
SM_DRAMPWROK:DRAM power ok
BUF_CPU_RST# → RESET#

SI2 change to 0201 12.19

DDR3 Compensation Signals

SM_RCOMP0 RC23 140_0402_1%
SM_RCOMP1 RC24 25.5_0402_1%
SM_RCOMP2 RC26 200_0402_1%

PU/PD for JTAG signals

XDP_TMS T40 @PAD
XDP_TDI T41 @PAD
XDP_TDO T42 @PAD
XDP_TCK T43 @PAD
XDP_TRST# T46 @PAD

SI2 change to 0201 12.19
C263 0.1U_0201_16V4Z
XDP_TRST# → C264 220P_0402_50V7K
PLT_RST# → C265 @ 100P_0402_50V8J
PM_SYS_PWRGD_BUF → C266 220P_0402_50V7K
BUF_CPU_RST#

XDP_DBRESET#_R → CC4 0.1U_0201_16V4Z
H_CPUPWRGD_R → C118 220P_0402_50V7K
SI2 change to 0201 12.19
6/27 Add ESD solution

+3VS, RC81 10K_0402_5%, CC2 0.1U_0402_16V4Z, +3V_PCH
UC2 74AHC1G09GW_TSSOP5
<16> SYS_PWROK, <16> PM_DRAM_PWRGD, @RC27 0_0402_5%, RC28 200_0402_5%
PM_SYS_PWRGD_BUF → RC25 200_0402_5% → +1.5V_CPU_VDDQ
Part Number = SA00003Y000
@RC29 39_0402_5%
<43,52> SUSP → @CC1 2N7002_SOT23
11.06 Change to +3V_PCH

2011.10.18 delete all reserved XDP conponent.
Just reserve test point for XDP.

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Title: PROCESSOR(2/7) PM,XDP,CLK
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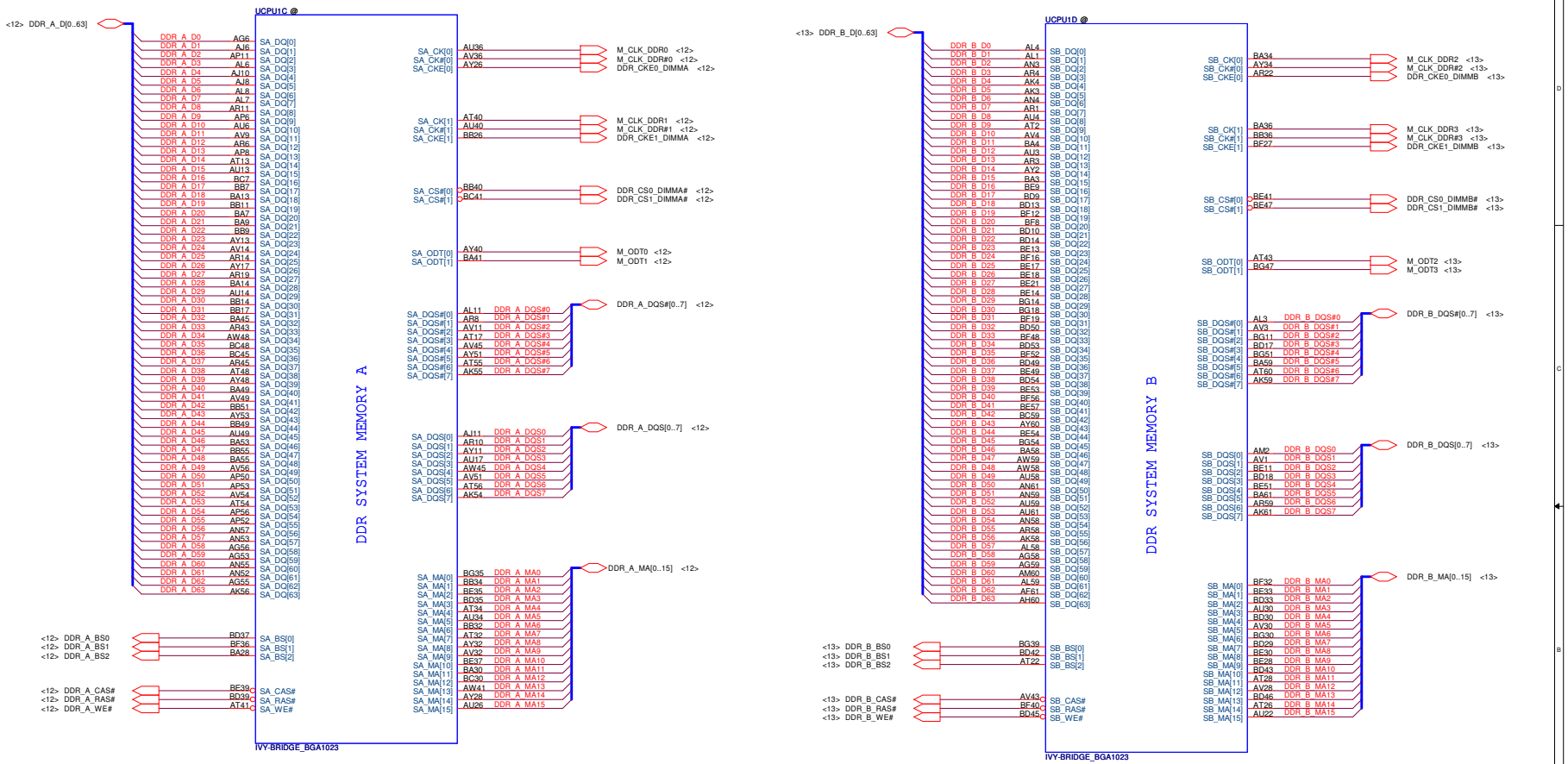

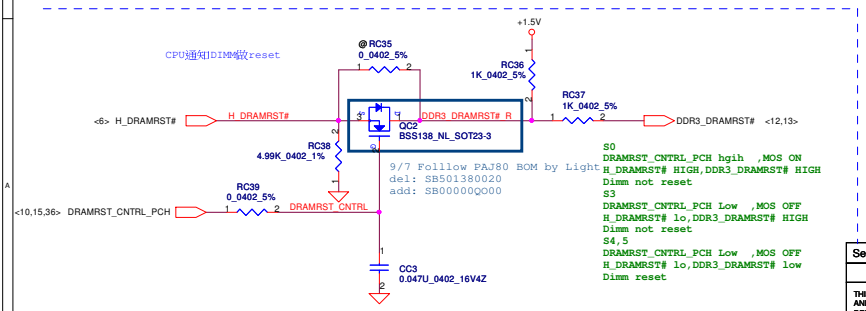

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Compal Electronics, Inc.

Title: PROCESSOR(3/7) DDRIII

Size	Document Number	Rev
Custom	LA-8041P	0.1

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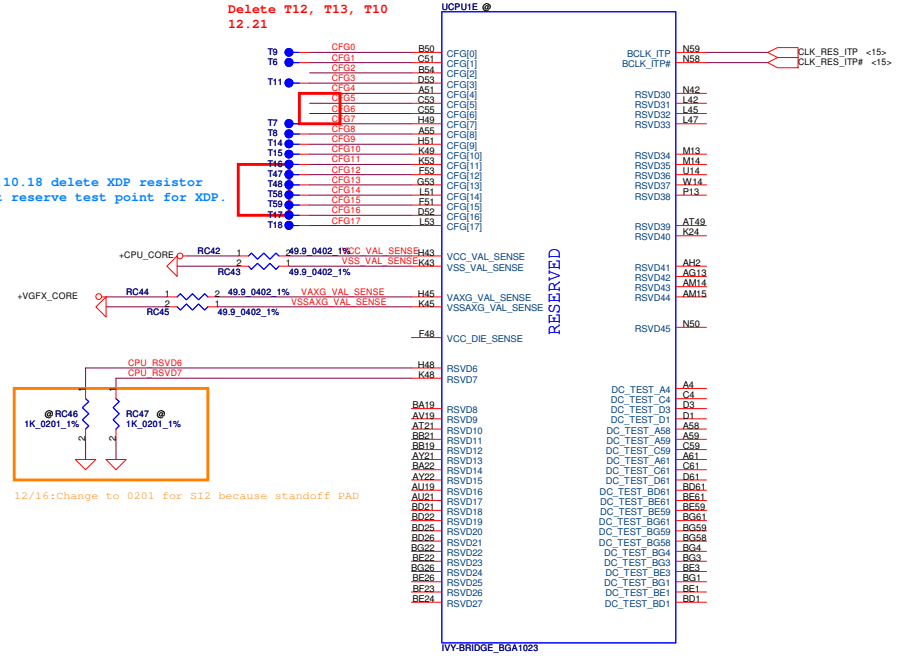
Change to part G.

Delete T12, T13, T10
12.21

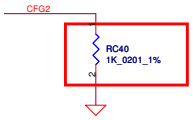
2011.10.18 delete XDP resistor
just reserve test point for XDP.



12/16:Change to 0201 for SI2 because standoff PAD

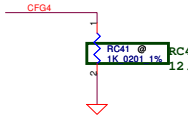
CFG Straps for Processor

PEG bus is reversed, need to PD.
11.01



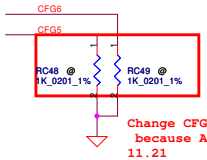
RC40 SI2 change to 0201
12.19

PEG Static Lane Reversal – CFG2 is for the 16x	
CFG2	* 1: Normal Operation; Lane # definition matches socket pin map definition 0:Lane Reversed



RC41 SI2 change to 0201
12.19

Display Port Presence Strap	
CFG4	* 1 : Disabled; No Physical Display Port attached to Embedded Display Port 0 : Enabled; An external Display Port device is connected to the Embedded Display Port

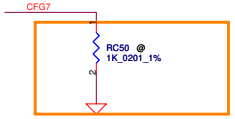


RC48, RC49 SI2 change to 0201
12.19

Change CFG[6:5] to 11 = 1 x 16 PCI Express
because AMD driver can't install issue
11.21

PCIE Port Bifurcation Straps	
CFG[6:5]	00 = 1 x 8, 2 x 4 PCI Express 01 = reserved 10 = 2 x 8 PCI Express 11 = 1 x 16 PCI Express *

12/16:Change to 0201 for SI2 because standoff PAD



PEG DEFER TRAINING	
CFG7	* 1: (Default) PEG Train immediately following xxRESETB de assertion 0: PEG Wait for BIOS for training

Security Classification	Compal Secret Data		
Issued Date	2011/06/29	Deciphered Date	2011/06/29

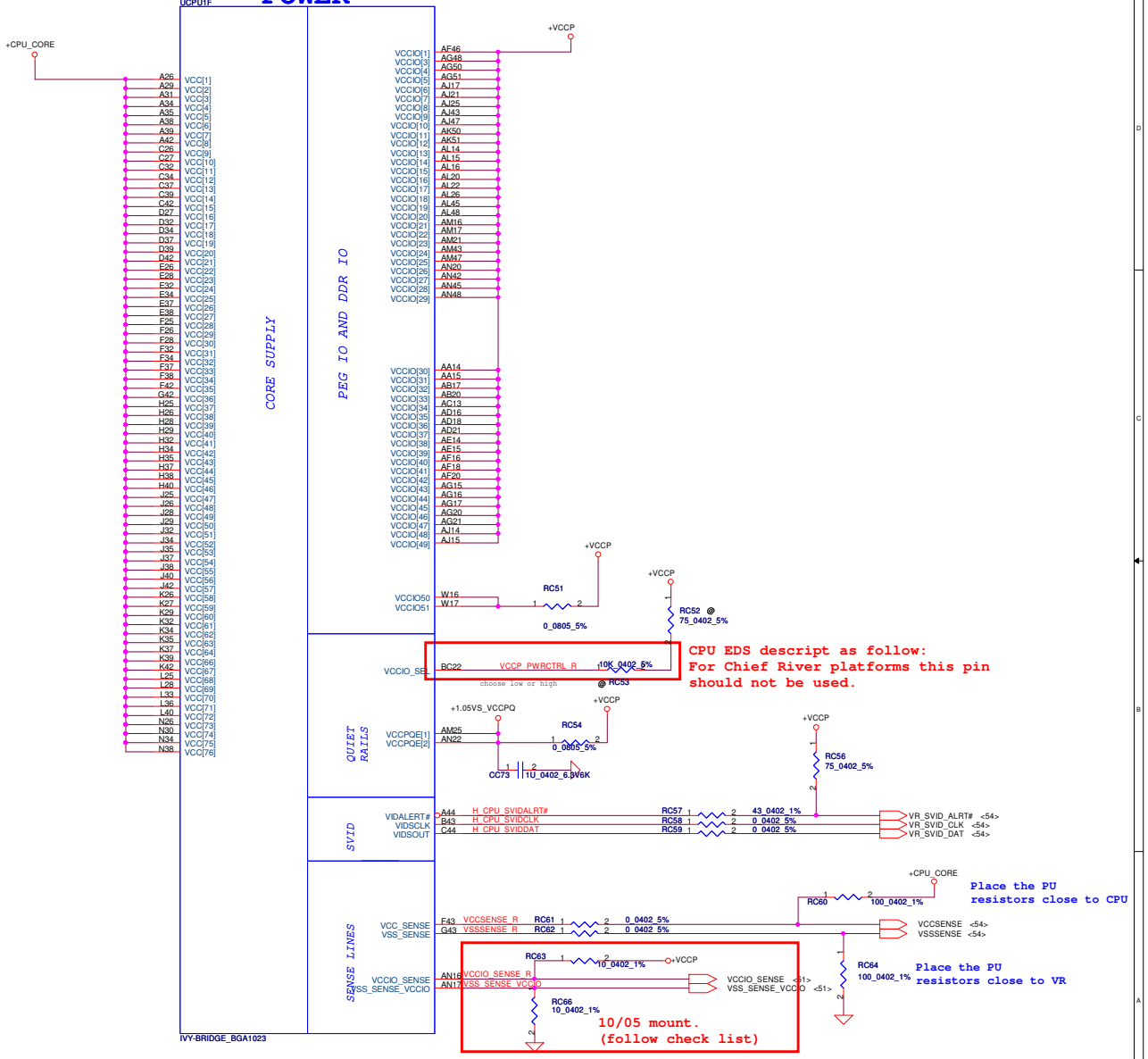
Compal Electronics, Inc.

Title: PROCESSOR(4/7) RSVD,CFG

Size	Document Number	Rev
Custom	LA-8661P	0.1

Date: Friday, March 02, 2012 Sheet 8 of 58

POWER



Security Classification	Compal Secret Data		
Issued Date	2011/06/29	Deciphered Date	2011/06/29

Compal Electronics, Inc.

Title: PROCESSOR(5/7) PWR,BYPASS

Size	Document Number	Rev
Custom	LA-8661P	0.1

Date: Friday, March 02, 2012 Sheet 9 of 58

POWER

- Can connect to GND if motherboard only supports external graphics and if GFX VR is not stuffed in a common motherboard design,
- VAXG can be left floating in a common motherboard design (Gfx VR keeps VAXG from floating) if the VR is stuffed

+V_SM_VREF should have 20 mil trace width

10/03 add +V_DDR_REFB

For Chief River only

M3 Circuit (Processor Generated SO-DIMM VREF_DQ)

10/03 add +V_DDR_REFB

Check with Power Team CC100 (330UF) can be taken off. 10.31

QC4 Change to SA0000JA00 for small package 1016

+1.5V_CPU_VDDQ Source

Follow DG 0.71 page 6

SI# BOM Change CC118 0.1u 25V form 0.1u 16V

Delete CC25 330U cap 10.19 (after check with power)

VID[0]	VID[1]		2011	2012
0	0	0.90 V	Yes	Yes
0	1	0.80 V	Yes	Yes
1	0	0.725 V	No	Yes
1	1	0.675 V	No	Yes

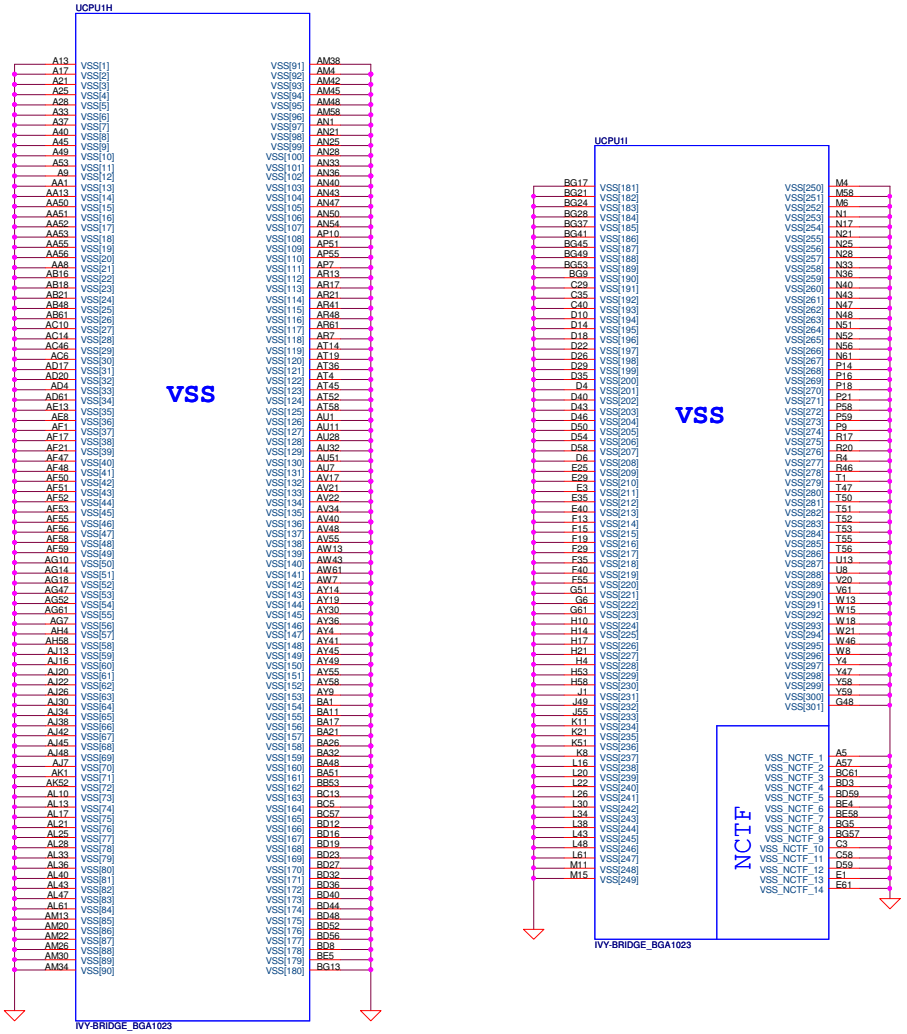
Security Classification	Compal Secret Data		
Issued Date	2011/06/29	Deciphered Date	2011/06/29

Compal Electronics, Inc.

Title: PROCESSOR(6/7) PWR

Size	Document Number	Rev
Custom	LA-8661P	0.1

Date: Friday, March 02, 2012 | Sheet 10 of 58



Security Classification	Compal Secret Data		
Issued Date	2011/06/29	Deciphered Date	2011/06/29

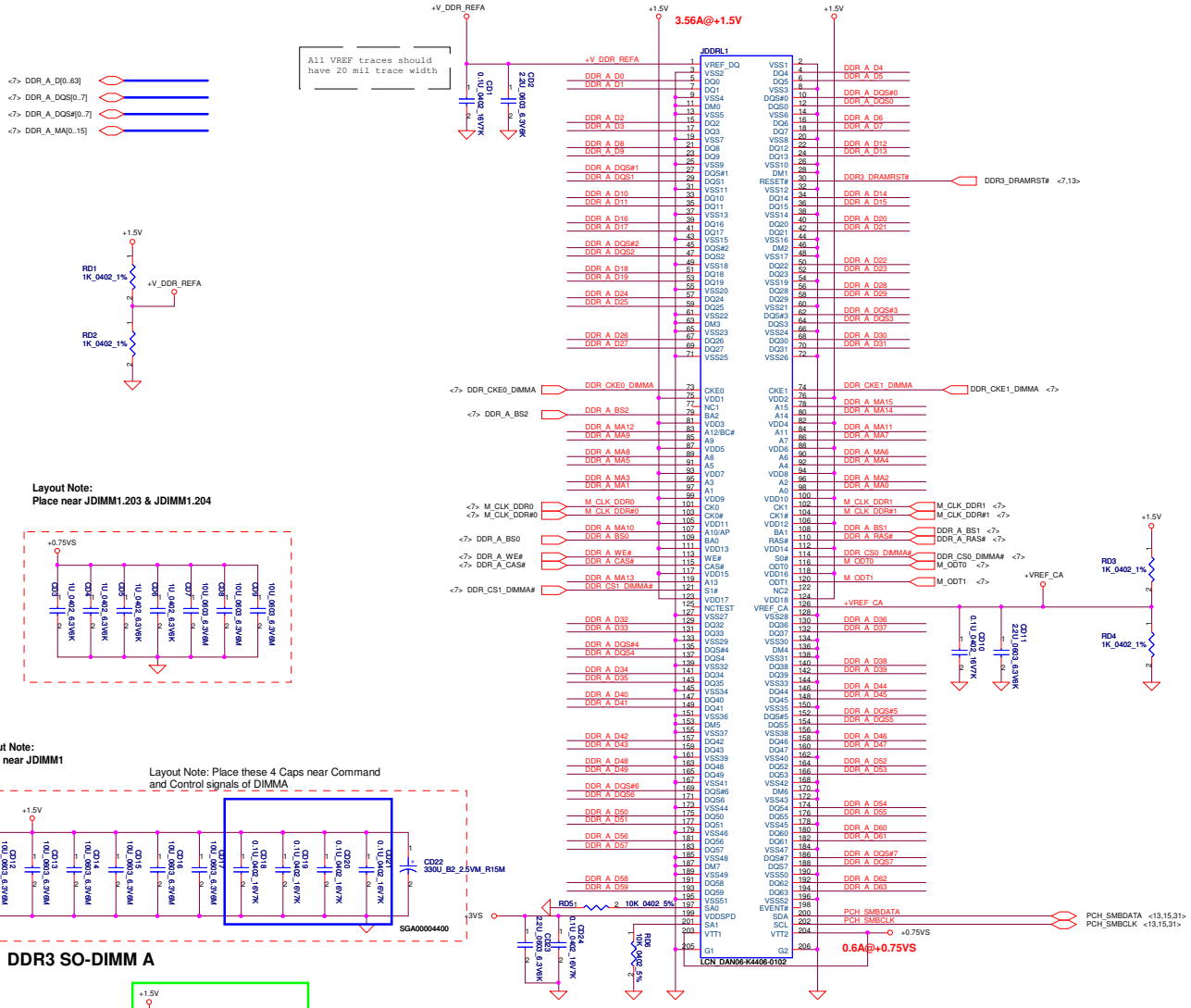
Compal Electronics, Inc.

Title: PROCESSOR(7/7) VSS

Size	Document Number	Rev
Custom	LA-8041P	0.1

Date: Friday, March 02, 2012 Sheet 11 of 58

DDR3 SO-DIMM A



Standard
<Address(SA1,SA0):00>

SI# 8/16 Reserve 4 pcs 0.1uF for EMI noise issue

A-8943P Security Classification	Compal Secret Data		
Issued Date	2011/06/29	Deciphered Date	2011/06/29

Title	DDRIII DIMM		
Size C	Document Number LA-8661P		Rev 0.1
Date: Friday, March 02, 2012	Sheet 12 of 58		

DDR3 SO-DIMM B

10/03 change to +V_DDR_REFB

3.56A@+1.5V

All VREF traces should have 20 mil trace width

<7> DDR_B_D[0..63]
<7> DDR_B_DQS[0..7]
<7> DDR_B_DQS#[0..7]
<7> DDR_B_MA[0..15]

Delete DDR_B_DM[0..7]

JDDRL2

DDR3_DRAMRST# <7,12>

Layout Note:
Place near JDIMM1.203 & JDIMM1.204

Layout Note:
Place near JDIMM1

Layout Note: Place these 4 Caps near Command and Control signals of DIMMA

10/03 change to +VREF_CB

0.6A@+0.75VS

10/05 change to PH.

Standard
<Address(SA1,SA0):10>

SI# 8/16 Reserve 4 pcs 0.1uF for EMI noise issue

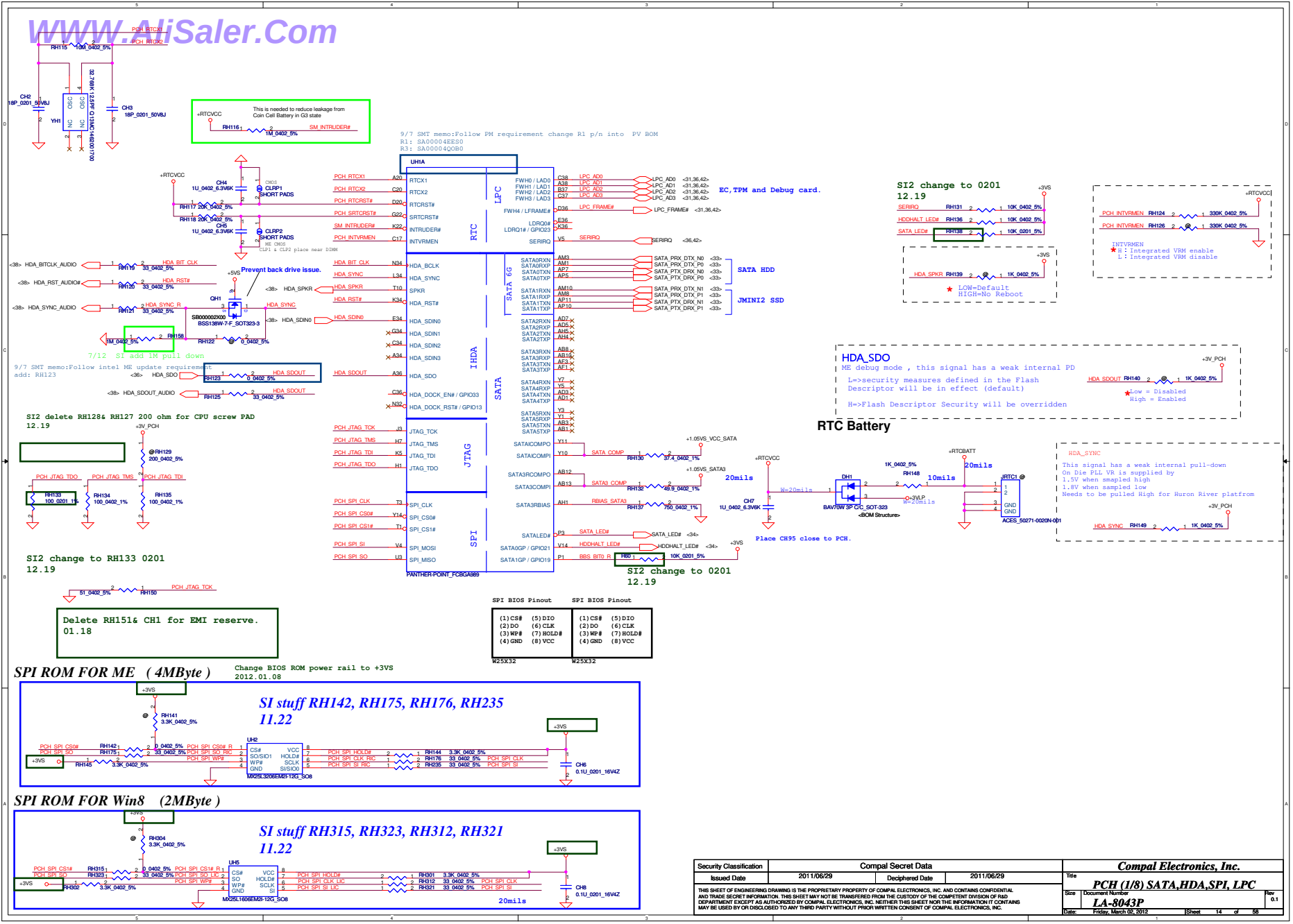
Security Classification	Compal Secret Data		
Issued Date	2010/05/27	Deciphered Date	2011/05/11

Compal Electronics, Inc.

Title: DDRIII-DDRH

Size	Document Number	Rev
	LA-8661P	0.1

Date: Friday, March 02, 2012 Sheet 13 of 58



Security Classification	Compal Secret Data		
Issued Date	2011/06/29	Deciphered Date	2011/06/29

Compal Electronics, Inc.			
Title: PCH (1/8) SATA,HDA,SPI, LPC			
Size:	Document Number: LA-8043P		Rev: 0.1
Date: Friday, March 02, 2012	Sheet 14 of 58		

10/03 change to PCIE port1.

PV# 9/13 change power rail form +3VALW->+3V_PCH

PCIE LAN/Card Reader

Mini card WLAN

UH1B

PCI-E*

SMBUS

Controller Link

CLOCKS

FLEX CLOCKS

PANTHER-POINT_FCBGA989

SI2 change to 0201 12.19

MiniWLAN

Change WL_OFF# to GPIO45 (pull-high) +3V_PCH 2012.01.04

SI2 YH2 change to SJ10000DJ00 12.19

Reserve for EMI please close to UH1

12/16:Change to 0201 for SI2

If use extenal CLK gen, please place close to CLK gen else, please place close to PCH

100MHz

2N7002DWH_SOT363-6

SI# 8/8 Add SML1CLK/SML1DATA for EC detect Thermal

Security Classification	Compal Secret Data		Compal Electronics, Inc.
Issued Date	2011/06/29	Deciphered Date 2011/06/29	Title: PCH (2/8) PCIE, SMBUS, CLK
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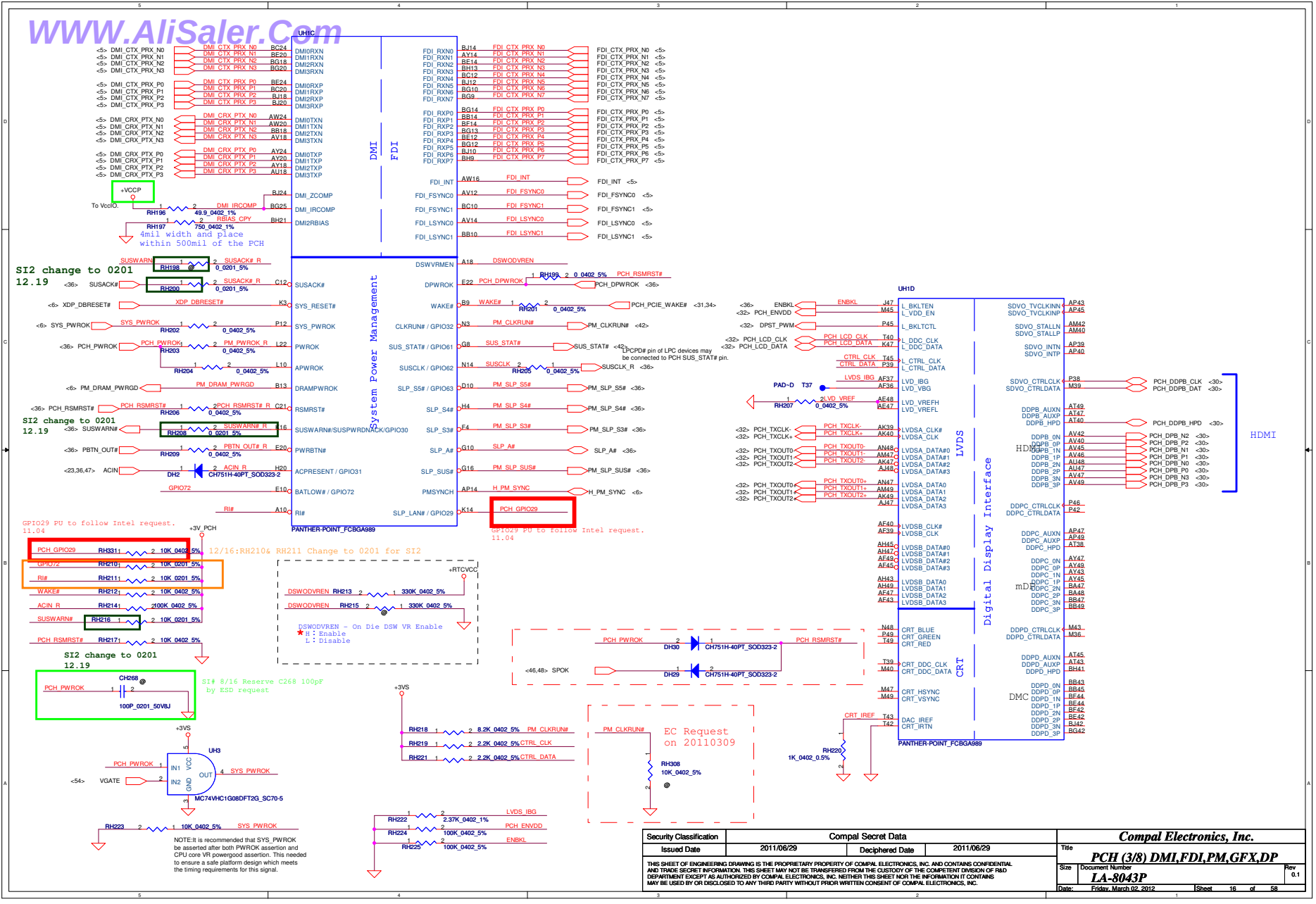
			Date: Friday, March 02, 2012 Sheet 15 of 58



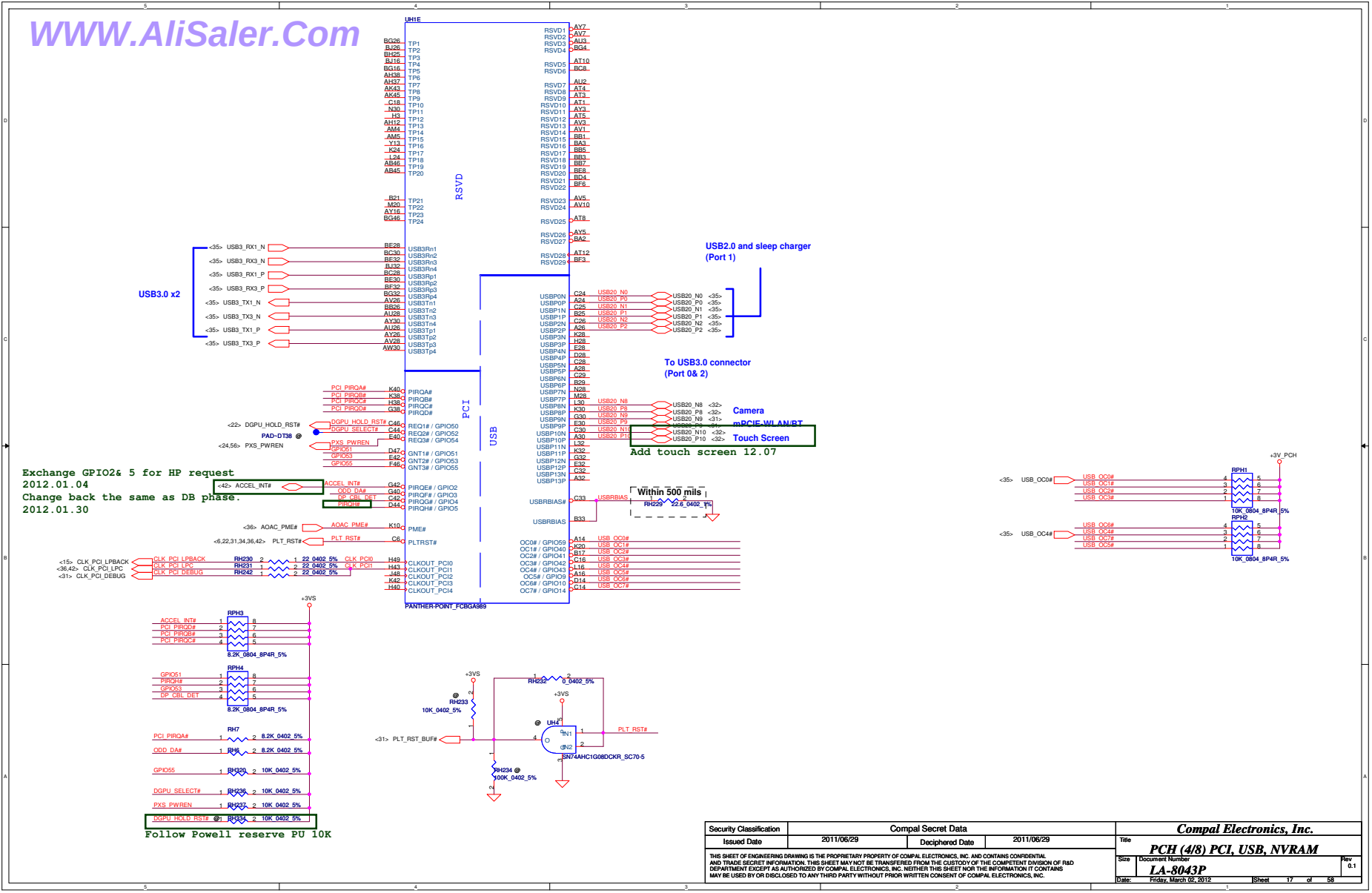
Security Classification	Compal Secret Data		
Issued Date	2011/06/29	Deciphered Date	2011/06/29

Compal Electronics, Inc.

Title: **PCH (3/8) DMI,FDI,PM,GFX,DP**

Size	Document Number	Rev
	LA-8043P	0.1

Date: Friday, March 02, 2012 Sheet 16 of 58



Security Classification	Compal Secret Data		Compal Electronics, Inc.
Issued Date	2011/06/29	Deciphered Date	2011/06/29
Title	PCH (4/8) PCI, USB, NVRAM		
Size	Document Number		Rev
	LA-8043P		0.1
Date: Friday, March 02, 2012	Sheet 17 of 58		

GPIO69 follow Intel's request PU. 11.04

GPIO28
On-Die PLL Voltage Regulator
This signal has a weak internal pull up
H : On-Die voltage regulator enable
L : On-Die PLL Voltage Regulator disable

PCH_GPIO37
FDI TERMINATION VOLTAGE OVERRIDE
LOW - Tx, Rx terminated to same voltage (DC Coupling Mode)

GPIO27
PCH_GPIO27 (Have internal Pull-High)
High: VCCVRM VR Enable
Low: VCCVRM VR Disable

DB# 10/20 Reserve GPIO 36 pull up resistor and add pull down resistor

Refer Powell change BT_ON to GPIO34 10.21

12/16:Change to 0201 for SI2

This signal should be connected to the processor's UNCOREPWRGD input to indicate when the processor power is valid.

Layout note: CLOSE TO THE BRANCHING POINT

SI2 change to 0201 12.19

SI2 change to 0201 12.19

12/20:Delete RH253 for SI2

SI2 change to 0201 12.19

SI# 8/8 change PCH_WAN_RADIO_OFF# to PCH_GPIO35

Security Classification	Compal Secret Data		
Issued Date	2011/06/29	Deciphered Date	2011/06/29

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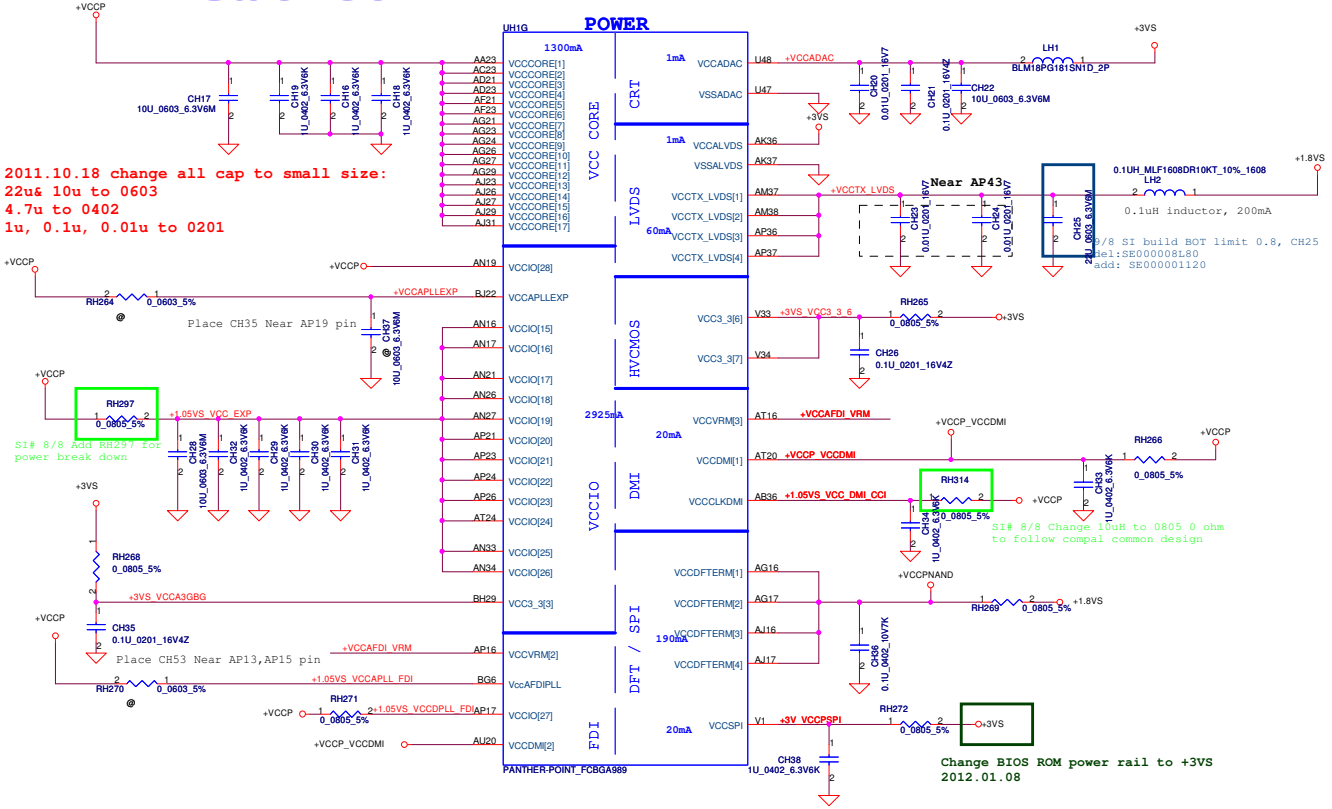
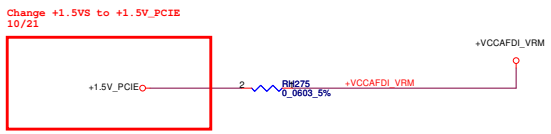
Compal Electronics, Inc.

Title: PCH (5/8) GPIO, CPU, MISC

Size	Document Number	Rev
	LA-8043P	0.1

Date: Saturday, March 03, 2012 Sheet 18 of 58





PCH Power Rail Table		
Voltage Rail	Voltage	S0 Iccmax Current (A)
V_PROC_IO	1.05	0.001
V5REF	5	0.001
V5REF_Sus	5	0.001
Vcc3_3	3.3	0.266
VccADAC	3.3	0.001
VccADPLLA	1.05	0.08
VccADPLLB	1.05	0.08
VccCore	1.05	1.3
VccDMI	1.05	0.042
VccIO	1.05	2.925
VccASW	1.05	1.01
VccSPI	3.3	0.02
VccDSW	3.3	0.003
VccpNAND	1.8	0.19
VccRTC	3.3	6 uA
VccSus3_3	3.3	0.119
VccSusHDA	3.3 / 1.5	0.01
VccVRM	1.8 / 1.5	0.16
VccCLKDMI	1.05	0.02
VccSSC	1.05	0.095
VccDIFFCLKN	1.05	0.055
VccALVDS	3.3	0.001
VccTX_LVDS	1.8	0.06

Security Classification	Compal Secret Data		
Issued Date	2011/06/29	Deciphered Date	2011/06/29

Compal Electronics, Inc.			
Title: PCH (6/8) PWR			
Size	Document Number: LA-8043P		Rev: 0.1
Date: Friday, March 02, 2012	Sheet 19 of 58		

VCC3_3 = 266mA detal waiting for newest spec
VCCDMI = 42mA detal waiting for newest spec

POWER

UH1J

PANTHER-POINT_FCBGA989

Clock and Miscellaneous
USB
PCI/GPIO/LPC
SATA
CPU
MISC
HDA
RTC

9/8 SI build BOT limit 0.8
del: SE000001120
add: SE000001120

SI# 7/29 Add RH307 for break down PCH VCCASW power

SI# 8/8 Add RH313 for follow compal common design

SI# 8/8 Delet the RH301,RH302,RH304 for follow compal common design

Place CH73 Near AK1 pin

All the CODEC I/O Voltages need to be at the same level either 3.3 V or 1.5 V.

9/8 SI build BOT limit 0.8, CH78, CH80
del:SE000008L80
add: SE000001120

7/8 CH78, CH80 220uF change to 22uF.

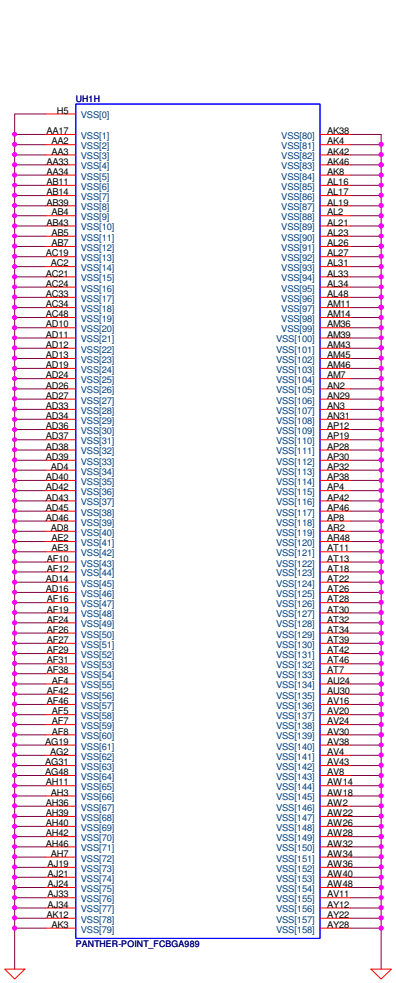
Security Classification	Compal Secret Data		
Issued Date	2011/06/29	Deciphered Date	2011/06/29

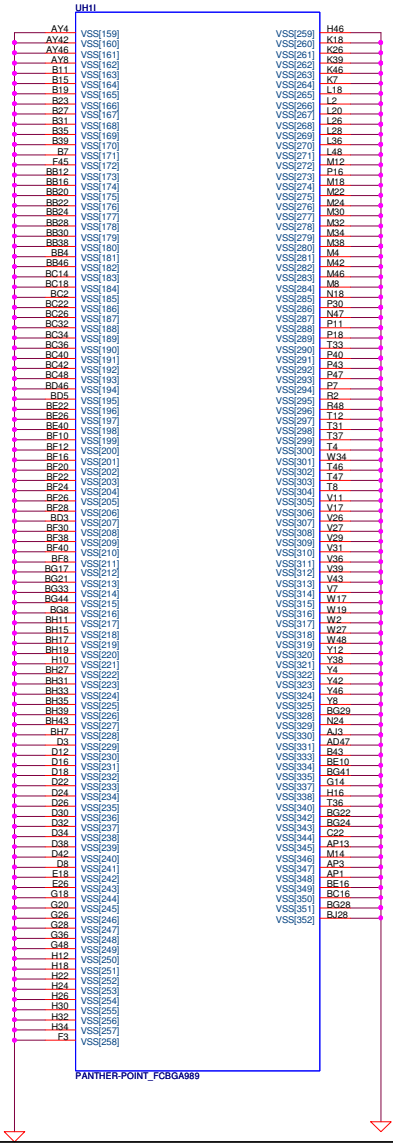
Compal Electronics, Inc.

Title: PCH (7/8) PWR

Size: | Document Number: LA-8043P | Rev: 0.1

Date: Friday, March 02, 2012 | Sheet 20 of 58





Security Classification	Compal Secret Data		
Issued Date	2011/06/29	Deciphered Date	2011/06/29

Compal Electronics, Inc.

Title: PCH (8/8) VSS

Size	Document Number	Rev
	LA-8043P	0.1

Date: Friday, March 02, 2012 | Sheet 21 of 58

Security Classification	Compal Secret Data		
Issued Date	2011/06/30	Deciphered Date	2013/06/30

Compal Electronics, Inc.

Title: ATI_SeymourXT_M2_PCIE/LVDS

Size	Document Number	Rev
C	LA7691P	0.1

Date: Friday, March 02, 2012 Sheet 22 of 58

Security Classification	Compal Secret Data		
Issued Date	2011/06/30	Deciphered Date	2013/06/30

Compal Electronics, Inc.

Title: ATI_SeymourXT_M2_Main_MSIC

Size	Document Number	Rev
C	LA7691P	0.1

Date: Friday, March 02, 2012 Sheet 23 of 58

Security Classification	Compal Secret Data		
Issued Date	2011/06/30	Deciphered Date	2013/06/30

Compal Electronics, Inc.

Title: ATI_SeymourXT_M2_BACO POWER

Size	Document Number	Rev
C	LA7691P	0.1

Date: Friday, March 02, 2012 Sheet 24 of 58

Security Classification	Compal Secret Data		
Issued Date	2011/06/30	Deciphered Date	2013/06/30

Compal Electronics, Inc.

Title: ATI_SetmourXT_M2_PWR_GND

Size	Document Number	Rev
C	LA7691P	0.1

Date: Friday, March 02, 2012 Sheet 25 of 58

Security Classification	Compal Secret Data		
Issued Date	2011/06/30	Deciphered Date	2013/06/30

Compal Electronics, Inc.

Title: ATI_SeymourXT_M2_Power

Size	Document Number	Rev
C	LA7691P	0.1

Date: Friday, March 02, 2012 Sheet 26 of 58

Security Classification	Compal Secret Data		
Issued Date	2011/06/30	Deciphered Date	2013/06/30

Compal Electronics, Inc.

Title: ATI_SeymourXT_M2_MEM IF

Size	Document Number	Rev
C	LA7691P	0.1

Date: Friday, March 02, 2012 Sheet 27 of 58

Security Classification	Compal Secret Data		
Issued Date	2011/06/30	Deciphered Date	2013/06/30

Compal Electronics, Inc.

Title: ATI_SeymourXT_M2_VRAM_A

Size	Document Number	Rev
C	LA7691P	0.1

Date: Friday, March 02, 2012 Sheet 28 of 58

Security Classification	Compal Secret Data		
Issued Date	2011/06/30	Deciphered Date	2013/06/30

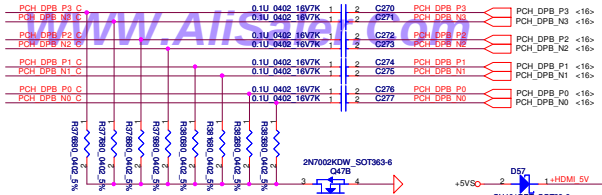
Compal Electronics, Inc.

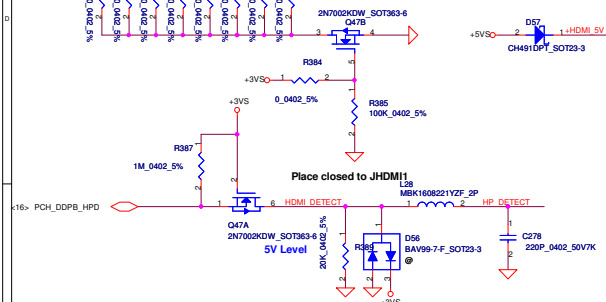
Title: ATI_SeymourXT_M2_VRAM_B

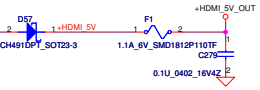
Size	Document Number	Rev
C	LA7691P	0.1

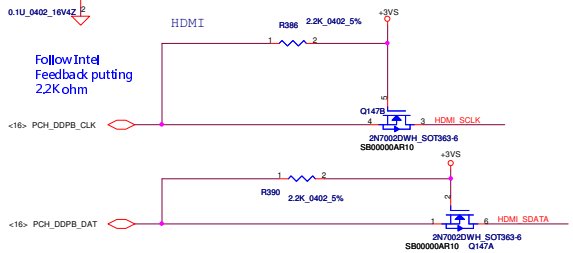
Date: Friday, March 02, 2012 Sheet 29 of 58

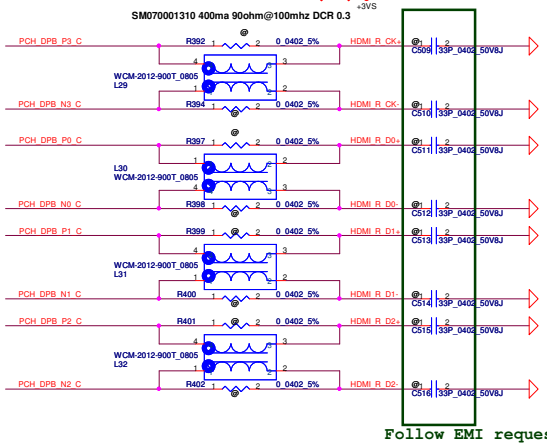
Del HDMI Repeater PS8271





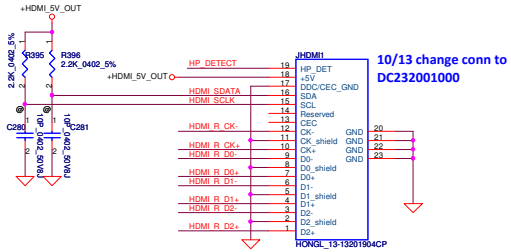






Follow EMI request add 33pF cap to GND.
11.02

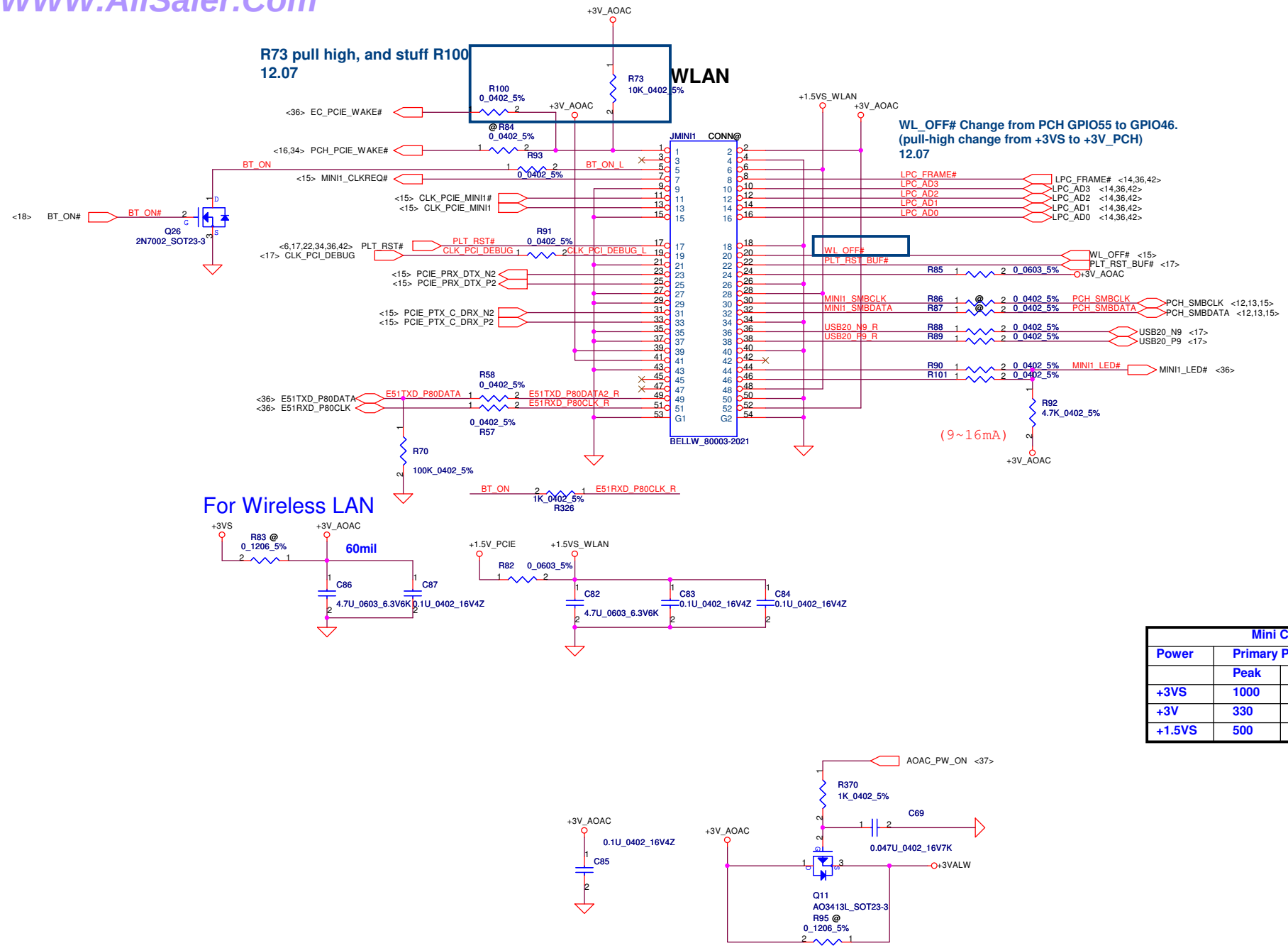
5V PULL UP IN CONNECTER SIDE



10/13 change conn to
DC232001000

Security Classification	Compal Secret Data		
Issued Date	2011/06/29	Deciphered Date	2011/06/29

Compal Electronics, Inc.			
Title: HDMI Conn			
Size	Document Number: LA-8042P		Rev: 0.1
Date: Friday, March 02, 2012		Sheet 30 of 58	



Mini Card Power Rating			
Power	Primary Power (mA)		Auxiliary Power (mA)
	Peak	Normal	Normal
+3VS	1000	750	
+3V	330	250	250 (wake enable)
+1.5VS	500	375	5 (Not wake enable)

Security Classification	Compal Secret Data		
Issued Date	2011/06/29	Deciphered Date	2011/06/29

Compal Electronics, Inc.

Title: MiniCard & WLan

Size: | Document Number: LA-8042P | Rev: 0.1

Date: Friday, March 02, 2012 | Sheet 31 of 58

LCD POWER CIRCUIT

+LCDVDD
+3VALW
+3VS
W=60mils
9/8 SI build BOT limit 0.8, CH55
del: SE053475Z80
add: SE107475K80
R61 100_0603_5%
R62 100K_0402_5%
R63 200K_0402_5%
C55 4.7U_0603_6.3V6K
Q6A DMN66D0LDW-7_SOT363-6
Q7 AO3413L_SOT23-3
C61 0.047U_0402_16V7K
C63 0.1U_0402_16V4Z
C62 4.7U_0603_6.3V6K
<16> PCH_ENVDD
PCH_ENVDD
Q6B DMN66D0LDW-7_SOT363-6
9/8 SI build BOT limit 0.8, C62
del: SE053475Z80
add: SE107475K80

Place closed to JLVDS1
C56 0.1U_0402_16V4Z
C57 10U_0603_6.3V6M
C58 0.1U_0402_16V4Z

INVPWR_B+
L7 FBMA-L11-201209-221LMA30T_0805
B+
W=60mils
C59 680P_0402_50V7K
C60 68P_0402_50V8J
SM010014520 3000ma
220ohm@100mhz
DCR 0.04

LCD/LED PANEL Conn.

W=60mils W=60mils

R64 2.2K_0402_5% LCD_CLK
R65 2.2K_0402_5% LCD_DATA
@C64 10P_0402_50V8J
@C65 10P_0402_50V8J
C66 220P_0402_50V7K INVTPWM
C67 220P_0402_50V7K DISPOFF#

+3VS& +5VS for touch screen (choose one when getting spec) 12.09

Change to smaller package
01.16

R156 0_0402_5%
L11
<17> USB20_P8
<17> USB20_N8
USB20_P8_R
USB20_N8_R
Part Number = SM070002900
WCM-1210HS-900T_4P
R229 0_0402_5%

Delete INVT_PWM because EC pin 25 need to connect to BATT_TEMPA

<16> DPST_PWM
R197 0_0402_5%
INVTPWM
R72 10K_0402_5%

R157 0_0402_5%
L12
<17> USB20_P10
<17> USB20_N10
USB20_P10_R
USB20_N10_R
<36>
WCM-2012-900T_4P
R230 0_0402_5%

Port 10 for touch screen
12.07

+LCDVDD
+5VS
JLVDS1
<16> PCH_LCD_CLK
<16> PCH_LCD_DATA
PCH_LCD_CLK
R193 0_0402_5% LCD_CLK
R194 0_0402_5% LCD_DATA
USB20_P10_R
USB20_N10_R
<6> PCH_TXOUT1-
<6> PCH_TXOUT1+
<6> PCH_TXOUT0-
<6> PCH_TXOUT0+
<6> PCH_TXOUT2+
<6> PCH_TXOUT2-
<16> PCH_TXCLK+
<16> PCH_TXCLK-
BKOFF#
R74 10K_0402_5%
INVTPWM
BKOFF#
USB20_N8_R
USB20_P8_R
INVPWR_B+
+3VS
<38> D_MIC_CLK
<38> D_MIC_DATA
D_MIC_CLK
D_MIC_DATA
STARC_111H40-100000-G4-R

For easier layout routing
change the pin order 12.08

D8
D_MIC_CLK
D_MIC_DATA
TVNST52302AB0_SOT523-3
Change to SCA00001W00
01.16

Security Classification	Compal Secret Data		
Issued Date	2011/06/29	Deciphered Date	2011/06/29

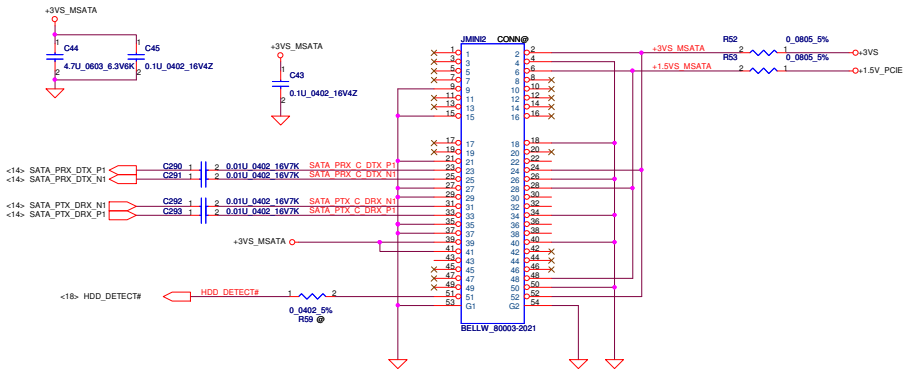
Compal Electronics, Inc.

Title: LVDS Connector

Size | Document Number: LA-8042P | Rev: 0.1

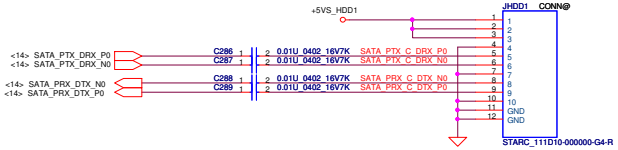
Date: Friday, March 02, 2012 | Sheet 32 of 58

mSATA Conn.

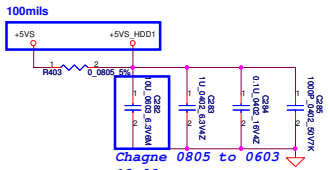


Exchange port 0 & port 1 for SI as customer request
11.30

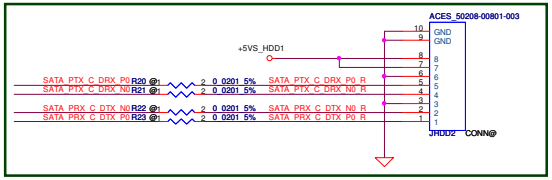
Change footprint to Starconn (PAD is bigger)
11.30



SATA connector



Chagne 0805 to 0603
12.08



Co-layout for wire type connector
01.16
Change connector to ACES_50376
01.31
Change connector to ACES_50208 because current limit issue
02.06

Security Classification	Compal Secret Data		
Issued Date	2011/06/29	Deciphered Date	2011/06/29

Compal Electronics, Inc.

Title: mSATA Connector

Size	Document Number	Rev
C	LA-8042P	0.1

Date: Friday, March 02, 2012 Sheet 33 of 58

W=60mils

W=60mils

+LAN_VDD_3V3 1.5A

These caps close to U1: Pin 11,12,39,58,63,64

Pin2 change to +5VALW cause power LED is on S/B 11.30

Add +5VS& more pin for +CR_VDD_3V3 2012.01.10

PANAS_AXK7L20213G

PN: SA00005B400

Strapping

Delete 0 ohm 11.05

SI2 Y9 change to SJ10000DJ00 12.19

Switching Regulator Circuit

Change from SH0000F400 to SH00000RK00 Z-high issue. 3/8

VDD33/18 for SD UHS Mode Power

EMI-ESD

Stuff D58 as EMI request 11.22

Correct footprint 02.13

TS1 change from SP050006X00 to SP050006Y00& SP050006P00 10/12

Change P/N from SCA00000T00 to SCA00001L00 11.01

Stuff D59 as EMI request 11.22

Add LAN LED White& Amber on M/B 10.12

Change power rail to +LAN_VDD_3V3 02.03

Security Classification	Compal Secret Data		
Issued Date	2011/06/29	Deciphered Date	2011/0/03

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Compal Electronics, Inc.

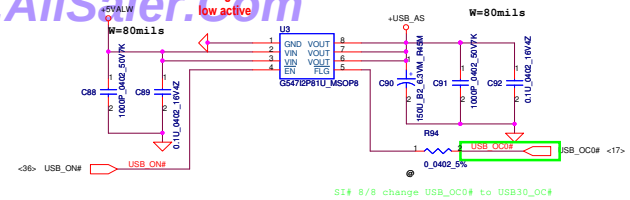
Title: LAN&CardReader Realtek RTL8411

Size | Document Number | Rev 0.1

Date: Thursday, March 08, 2012 | Sheet 34 of 58

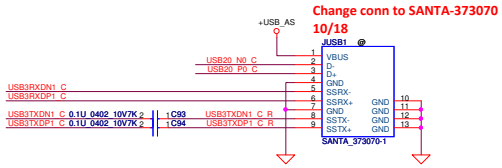
USB3.0

USB3.0 need support 2.5A
change USB PWR SW SA00003TV00
low active

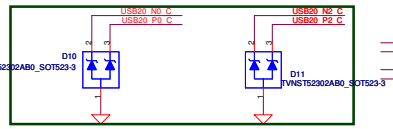


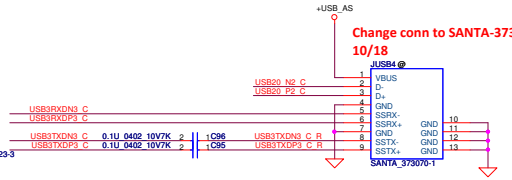
SI# 8/8 change USB_OC0# to USB30_OC#

Change conn to SANTA-373070
10/18

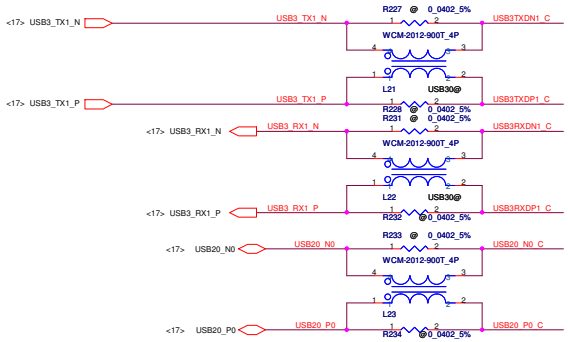


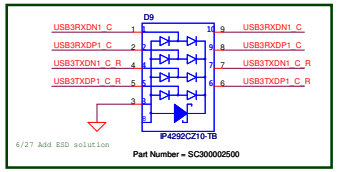
Change P/N from SCA00000T00 to SCA00001L00
11.01
Change P/N to SCA00001W00 for smaller size, 10*10 choke
02.13

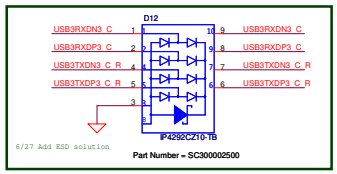


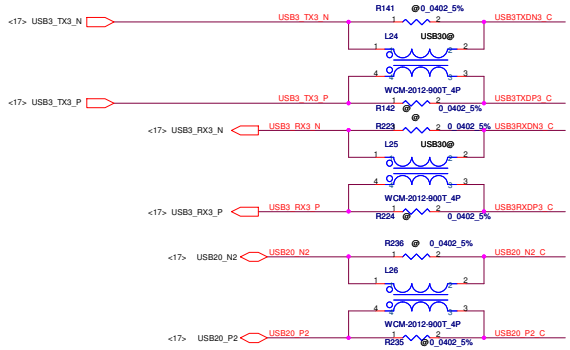


Change conn to SANTA-373070
10/18









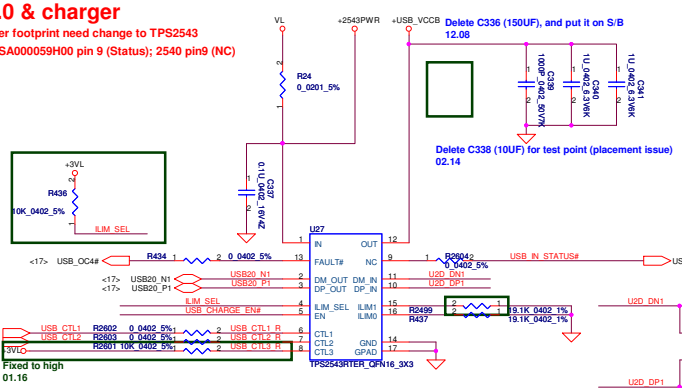
USB2.0 & charger

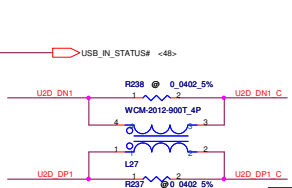
USB charger footprint need change to TPS2543
TPS2543 : SA000059H00 pin 9 (Status); 2540 pin9 (NC)

Delete C336 (150UF), and put it on S/B
12.08

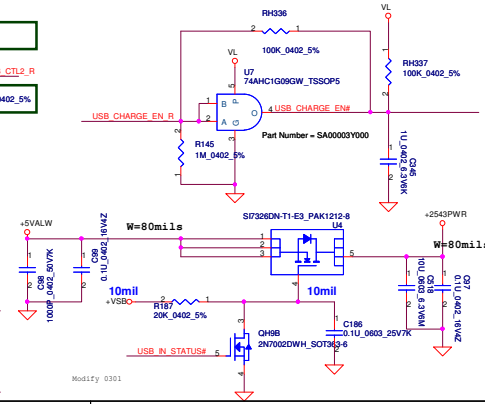
Delete C338 (10UF) for test point (placement issue)
02.14

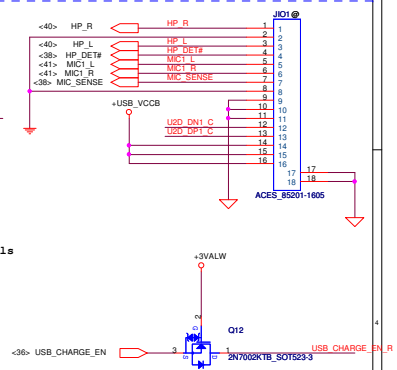
Delete pull-high resistors
01.16





Follow EMI request add choke
11.08





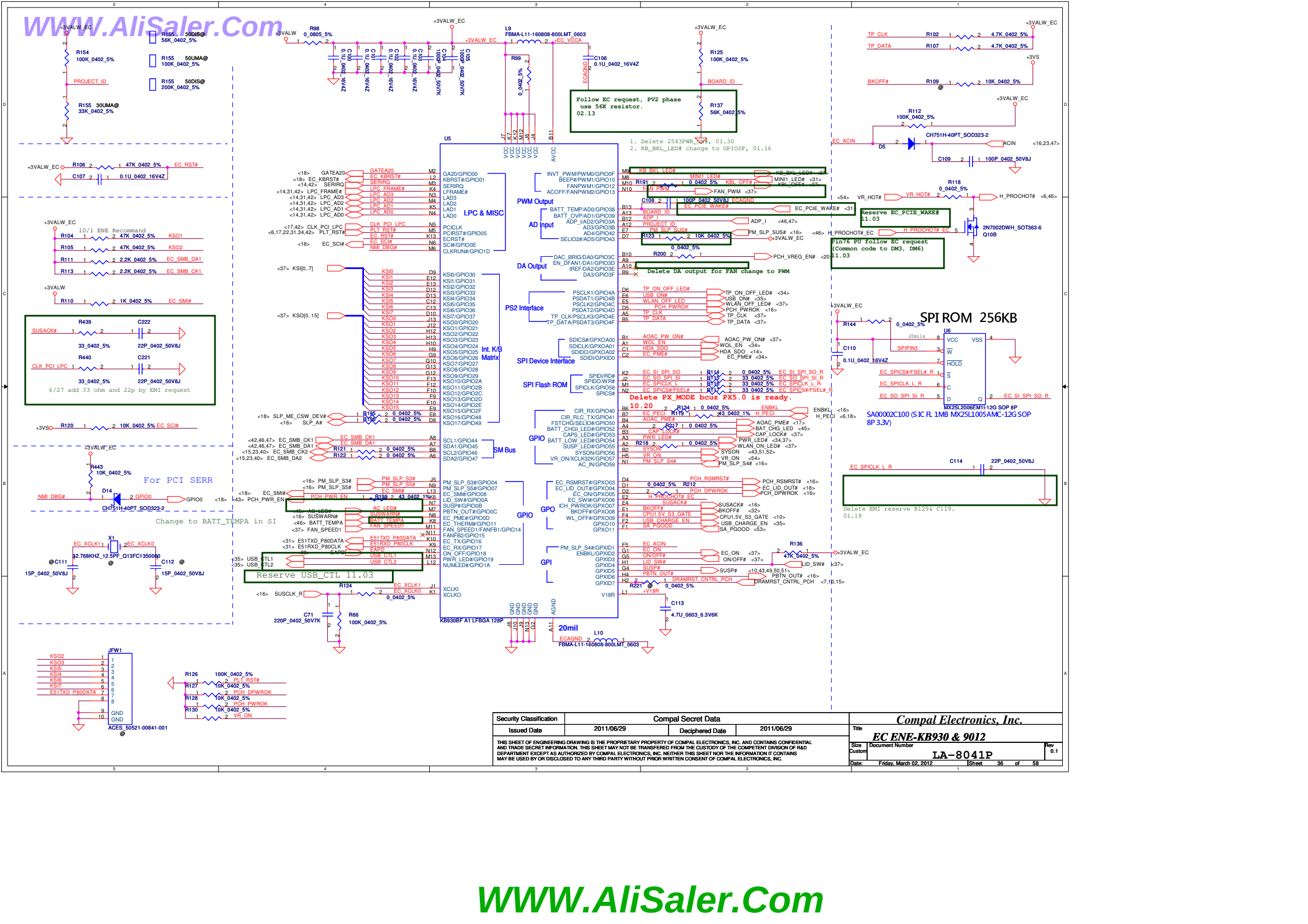
Security Classification	Compal Secret Data		
Issued Date	2011/06/29	Deciphered Date	2011/06/29

Compal Electronics, Inc.

Title: USB Con & Daughter Con

Size: C | Document Number | Rev: 0.1

Date: Monday, March 05, 2012 | Sheet 35 of 58



Security Classification	Compal Secret Data		
Issued Date	2011/06/29	Deciphered Date	2011/06/29

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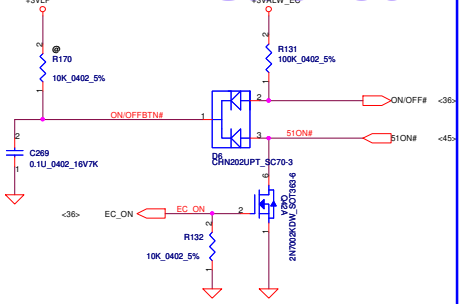
Compal Electronics, Inc.

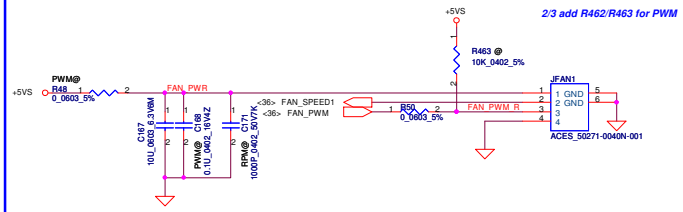
Title: EC ENE-KB930 & 9012

Size: Custom | Document Number: LA-8041P | Rev: 0.1

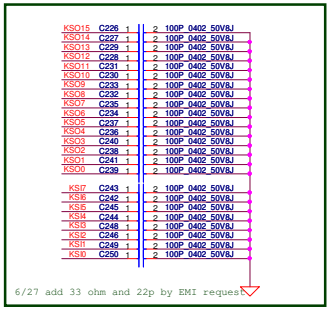
Date: Friday, March 02, 2012 | Sheet 36 of 58

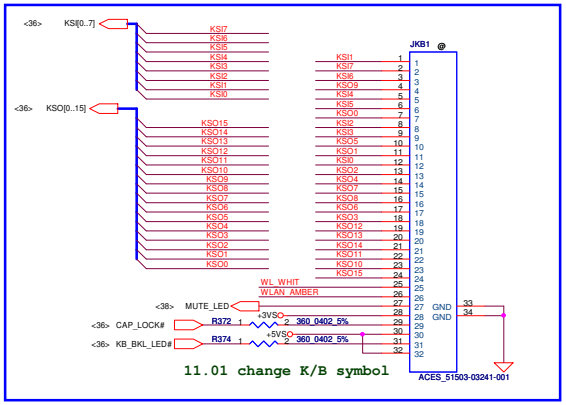


PWM Fan Control circuit



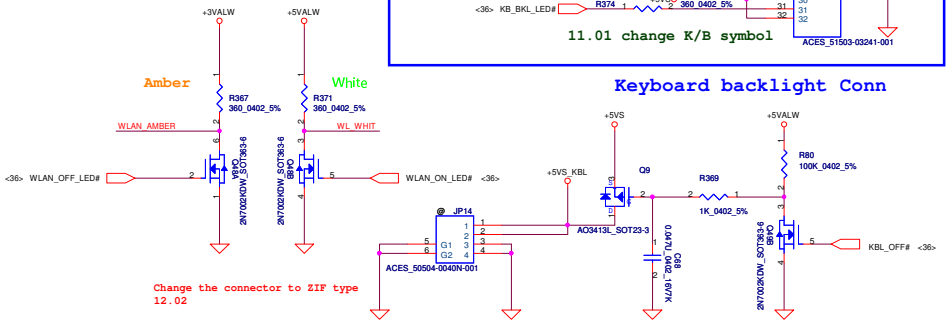
Follow thermal (FAN) design guide, pull-high 10K
12.05



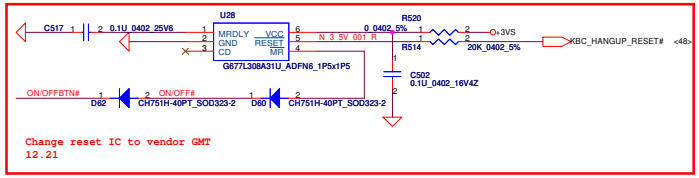


11.01 change K/B symbol

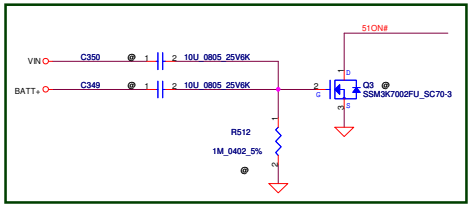
Keyboard backlight Conn

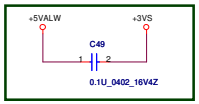


Change the connector to ZIF type
12.02

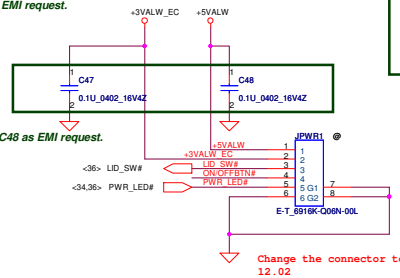


Change reset IC to vendor GMT
12.21



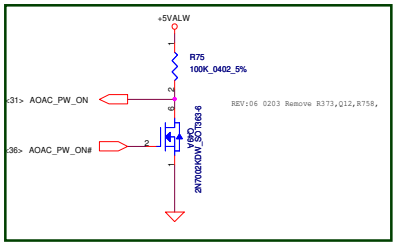


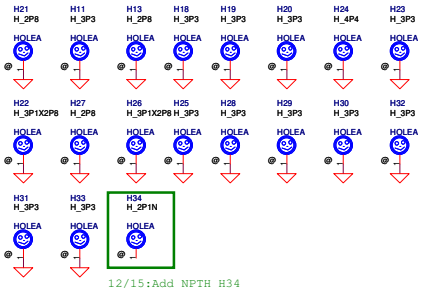
Add C49 as EMI request.
12.05



Add C47, C48 as EMI request.
12.05

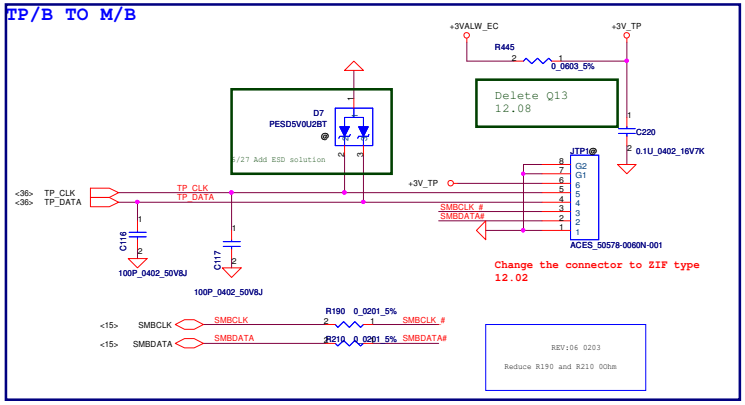
Change the connector to ZIF type
12.02



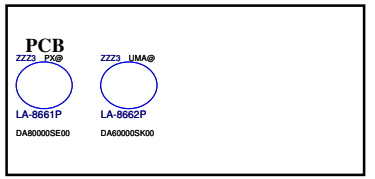


12/15:Add NPTH H34

TP/B TO M/B



Change the connector to ZIF type
12.02



FD1 FD2 FD3 FD4
FIDUCIAL_C40M80 FIDUCIAL_C40M80 FIDUCIAL_C40M80 FIDUCIAL_C40M80

Security Classification	Compal Secret Data		Compal Electronics, Inc.
Issued Date	2011/06/29	Deciphered Date 2011/06/29	Title: KB/TP/LED/FAN/Screw/Gsensor
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			Date: Saturday, March 03, 2012; Sheet 37 of 58

WWW.AliSaler.Com

DVDD_IO should match
with HDA Bus level(optional for 3.3V signaling or 1.5V signaling)

Notes:
Keep PVDD supply and speaker traces routed on the DGND plane.
Keep away from AGND and other analog signals

Place AVDD ,PVDD,and DVDD capacitor close to Codec

PLACE CLOSE TO U1 PIN 13

If Sense_A total length is greater than 6 inches, chagne C12 to 0.1uF

PLACE CLOSE TO U1 PIN 14

If Sense_B is un-used, then pull high Sense_B to AVDD by 10Kohm resistor

Follow EMI request, reserve cap. 11.03

Correct CA508 circuitry. 12.05

HP Jack

Ext MIC

Internal SPKR(front stereo speaker)

Place C208 close to Codec

Place C209,C210,CA87,CA89 close to Codec

Follow EMI request, reserve cap. 11.03

SB Beep

9/27 LDO TPS793475DBVR for audio power

Change UA2 P/N to SA00005J000 just for HP project. 02.06

GND GNDA

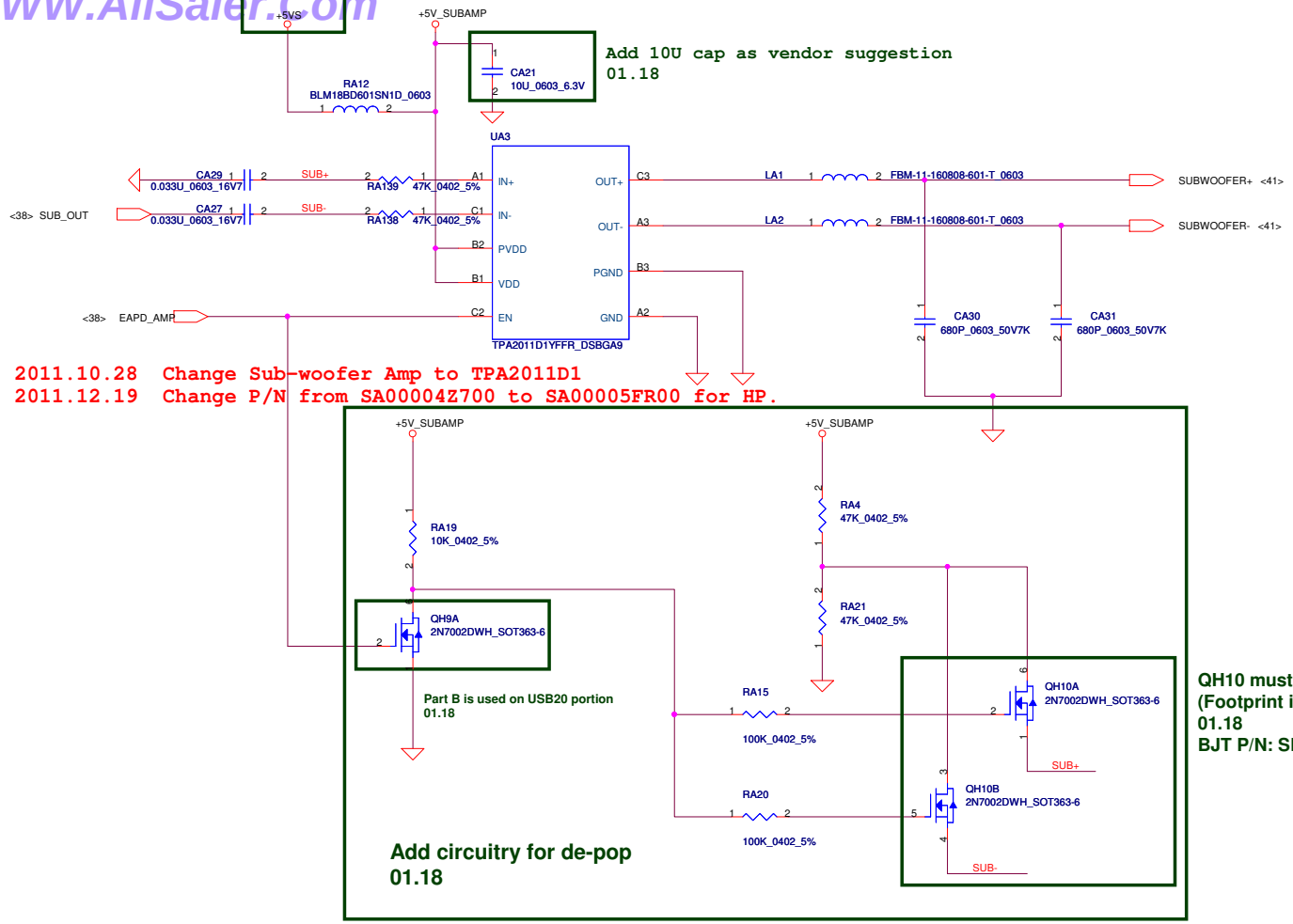
Security Classification	Compal Secret Data		
Issued Date	2011/06/29	Deciphered Date	2011/06/29

Compal Electronics, Inc.

Title: Audio IDT 92HD91

Size: Custom | Document Number | Rev: 0.1

Date: Friday, March 02, 2012 | Sheet 38 of 58



QH10 must change to BJT before SMT
(Footprint is compatible from BJT& MOTFET)
01.18
BJT P/N: SB00000VH00

Security Classification	Compal Secret Data		
Issued Date	2011/06/29	Deciphered Date	2011/06/29

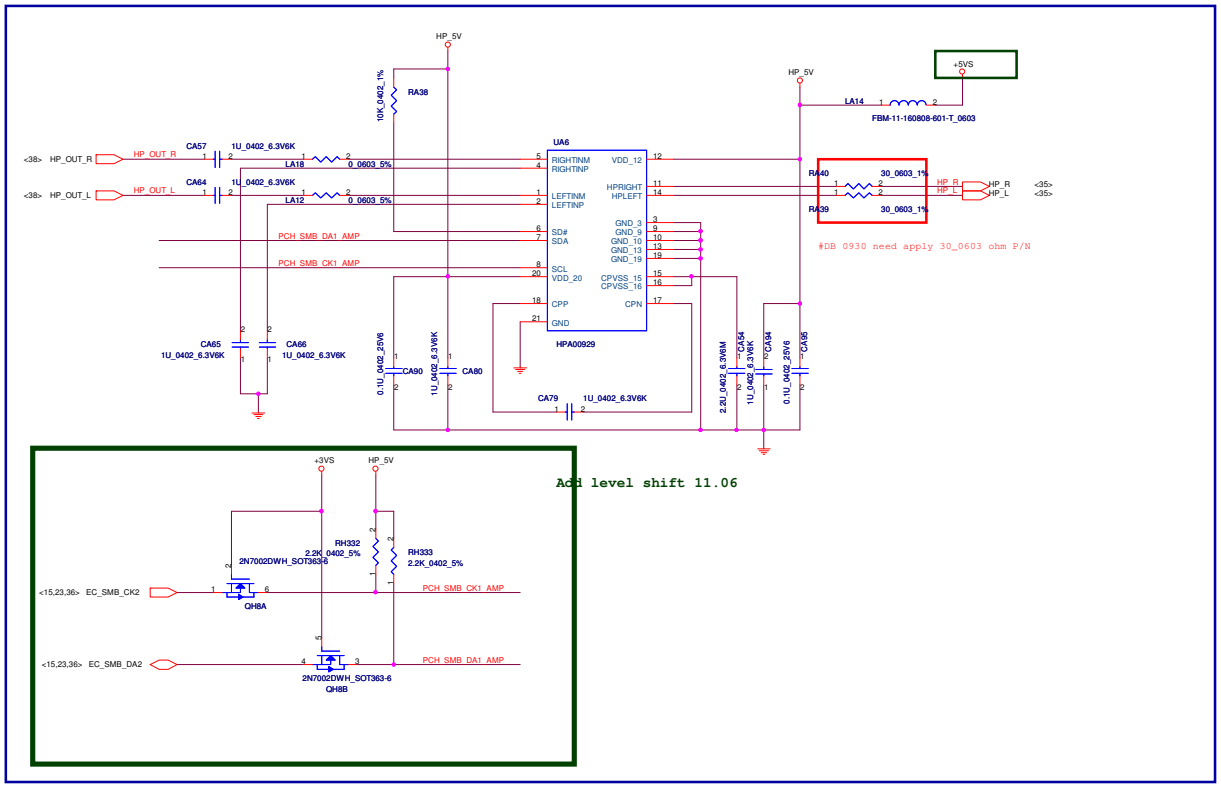
Compal Electronics, Inc.

Title: Audio Woofer Amplifier

Size	Document Number	Rev
B		0.1

Date: Friday, March 02, 2012 Sheet 39 of 58

Headphone amplifier



Security Classification	Compal Secret Data		
Issued Date	2011/06/29	Deciphered Date	2011/06/29

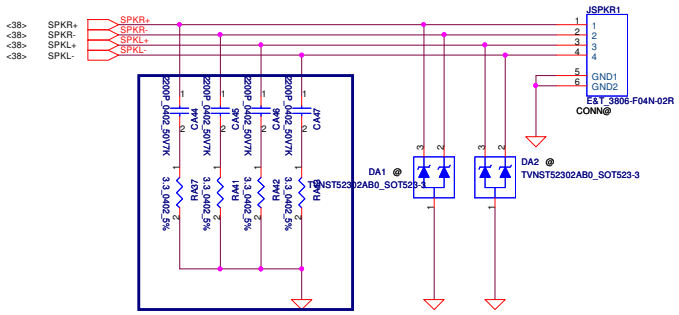
Compal Electronics, Inc.

Title: Audio SPK/HP Amplifier

Size	Document Number	Rev
Custom		0.1

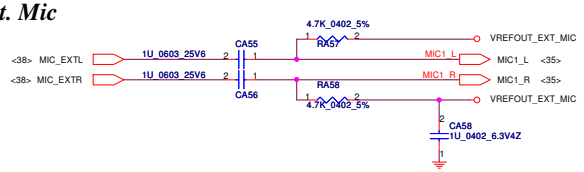
Date: Wednesday, March 07, 2012 Sheet 40 of 58

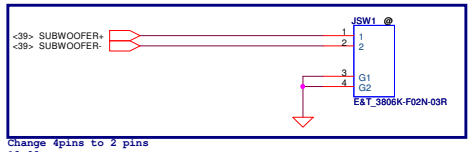
Front Speaker Connector 1



Need place rear Audio Codec (UA5)

Ext. Mic





Change 4pins to 2 pins
12.08

Security Classification	Compal Secret Data		
Issued Date	2009/04/07	Deciphered Date	2012/10/21

Compal Electronics, Inc.

Title: Audio SPK Conn/Jack/MIC

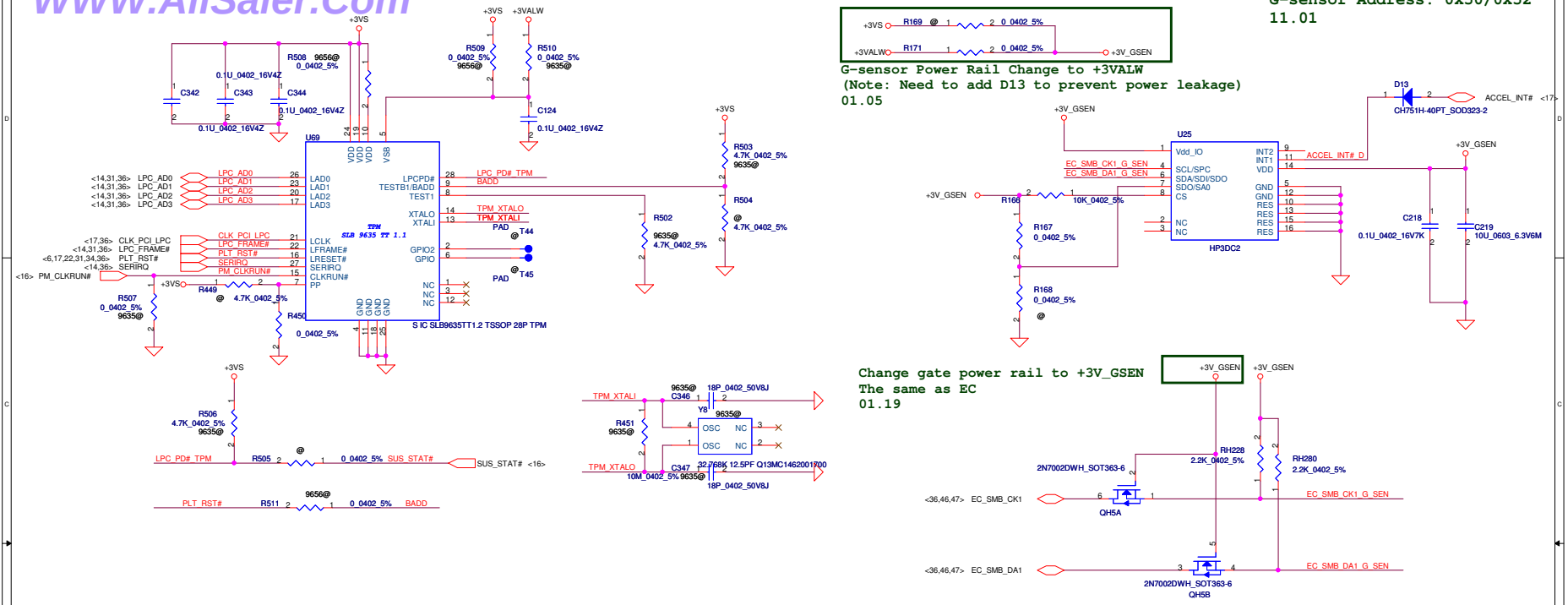
Size	Document Number	Rev
Custom	PAV10	0.1

Date: Friday, March 02, 2012 Sheet 41 of 58

G-sensor Address: 0x50/0x52
11.01

G-sensor Power Rail Change to +3VALW
(Note: Need to add D13 to prevent power leakage)
01.05

Change gate power rail to +3V_GSEN
The same as EC
01.19



Security Classification	Compal Secret Data		
Issued Date	2006/09/25	Deciphered Date	2006/09/25

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Compal Electronics, Inc.

Title: **TCG/BIOS ROM/PS2/LED/SW**

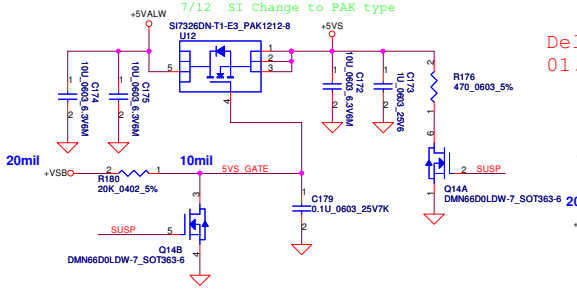
Size	Document Number	Rev
	LA3262P_DIS__M64	0.1

Date: Wednesday, March 07, 2012 | Sheet 42 of 58

10.21 Change to PAK type

+5VALW TO +5VS

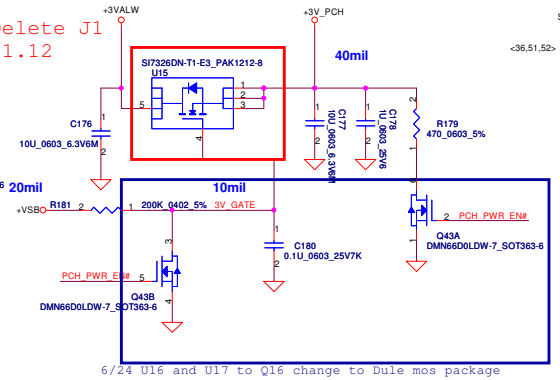
7/12 SI Change to PAK type



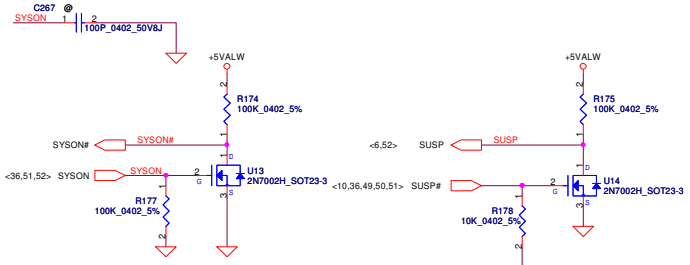
+3VALW TO +3VALW(PCH AUX Power)

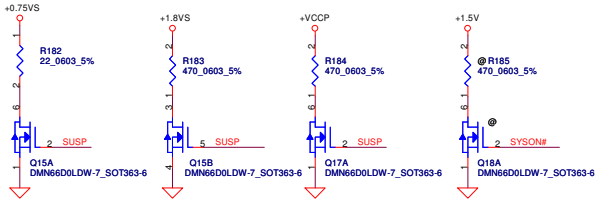
Short J1 for PCH VCCSUS3.3

Delete J1
01.12

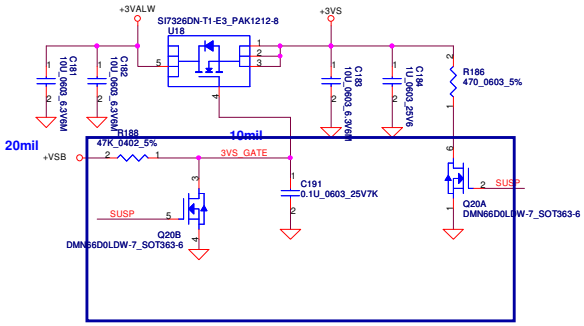


6/24 U16 and U17 to Q16 change to Dule mos package

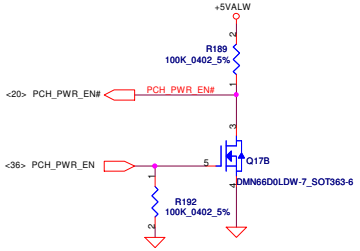




+3VALW TO +3VS



6/24 Q20 and Q21 to Q20 change to Dule mos package



Security Classification	Compal Secret Data		
Issued Date	2011/06/29	Deciphered Date	2011/06/29

Compal Electronics, Inc.

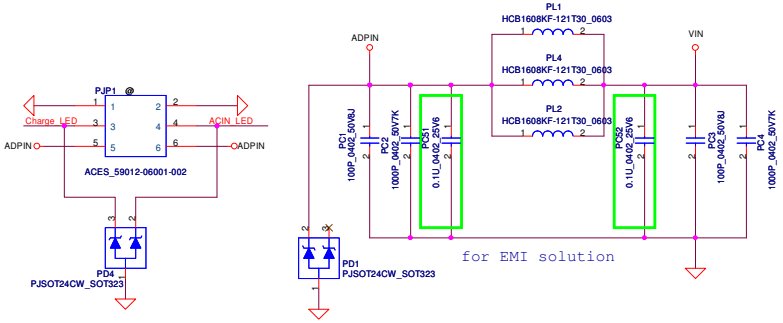
Title: DC Interface

Size	Document Number	Rev
Custom	LA-8661P	0.1

Date: Friday, March 02, 2012 Sheet 43 of 58

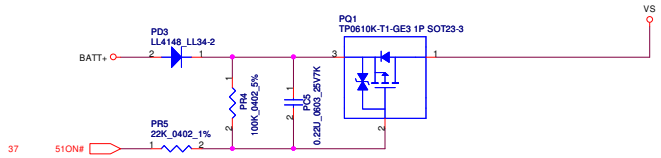
	QAZ60 Strap pin Table		@:un_install	
	Netname	setting	BOM config	
CPU	CFG2	1	RC40 @	1: Normal Operation; Lane # definition matchessocket pin map definition 0: Lane Reversed
	CFG4	1	RC41 @	1 : Disabled; No Physical Display Portattached to Embedded Display Port 0 : Enabled; An external Display Port device is connected to the Embedded Display Port
	CFG[6:5]	0 1	RC49 RC48 @	11: (Default) x16 - Device 1 functions 1 and 2 disabled 10: x8, x8 - Device 1 function 1 enabled ; function 2 disabled 01: Reserved - (Device 1 function 1 disabled ; function 2 enabled) 00: x8,x4,x4 - Device 1 functions 1 and 2 enabled
	CFG7	1	RC50 @	1: (Default) PEG Train immediately following xxRESETB de assertion 0: PEG Wait for BIOS for training
PCH	PCH_INTVRMEN	H	RH124 RH126 @	H : Integrated VRM enable L : Integrated VRM disable
	HDA_SPKR	L	RH139 @	H:No Reboot L:Default
	HDA_SYNC	H	RH149	This signal has a weak internal pull-downOn Die PLL VR is supplied by H:1.5V when smapled high L:1.8V when sampled low Needs to be pulled High for Huron River platfrom
	HDA_SDOUT	L	RH140 @	ME debug mode , this signal has a weak internal PD L=>security measures defined in the Flash Descriptor will be in effect (default) H=>Flash Descriptor Security will be overridden
	DSWODVREN	H	RH213 RH215 @	On Die DSW VR Enable H : Enable L : Disable
	SLP_ME_CSW_DEV#	H	RH267 RH241 @	On-Die PLL Voltage Regulator This signal has a weak internal pull up H : On-Die voltage regulator enable L : On-Die PLL Voltage Regulator disable
	PCH_GPIO37	L	RH245 @ RH246	FDI TERMINATION VOLTAGE OVERRIDE L: Tx, Rx terminated to same voltage(DC Coupling Mode)
	GPIO27	H	RH250 @	PCH_GPIO27 (Have internal Pull-High) H: VCCVRM VR Enable L: VCCVRM VR Disable

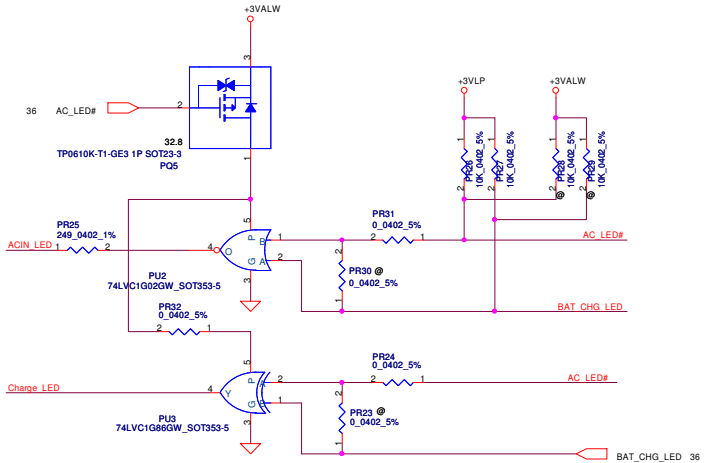
Compal Electronics, Inc.			
Title: Strap pin table			
Size: Custom	Document Number: LA-8041P		Rev: 0.1
Date: Friday, March 02, 2012	Sheet 44 of 58		



ESD diode : SCA00001G00

KBC output		Input to Battery		
AC_LED#	BAT_CHG_LED	ACIN_LED	Charge_LED	LED Status
0	0	1	0	White LED light
0	1	0	1	Amber LED light
1	0	0	0	X (don't care)
1	1	0	0	X (don't care)





Security Classification	Compal Secret Data		
Issued Date	2011/10/03	Deciphered Date	2014/12/31

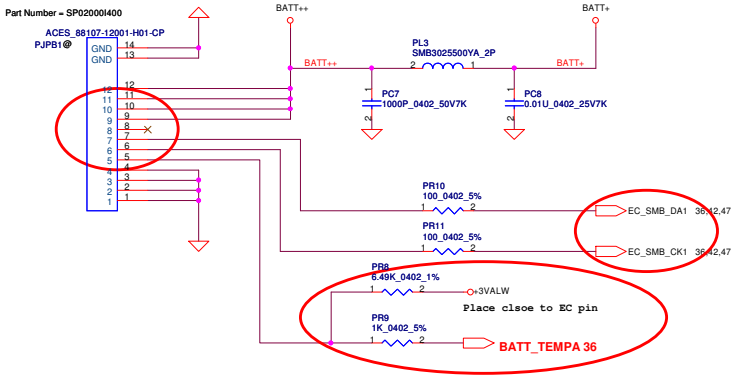
Compal Electronics, Inc.

Title: PWR- DCIN / Vin Detector

Size	Document Number	Rev
Custom	LA-8551P	0.1

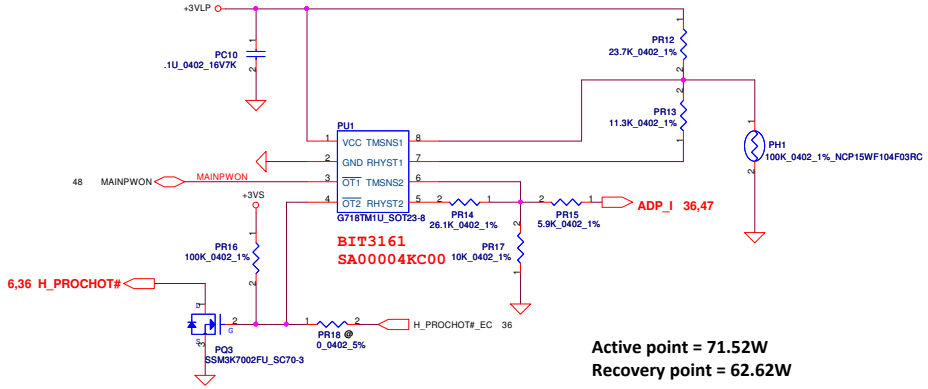
Date: Saturday, March 03, 2012 Sheet 45 of 59

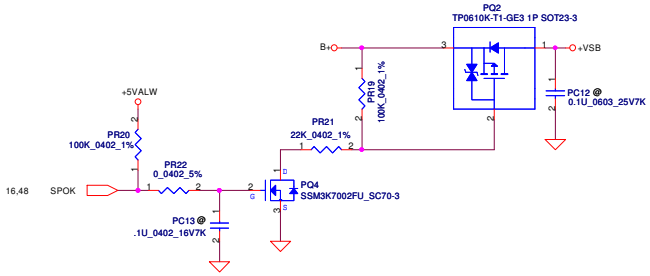
For KB930 --> Keep PU1 circuit
(Vth = 0.825V)



PH1 under CPU botten side :
CPU thermal protection at 90 +-3 degree C
Recovery at 56 +-3 degree C

Rset = 3 * Rtmh
Rhyst = (Rset* Rtml) / (3*Rtml - Rset)
Rtmh at 90C = 7.8K, Rtml at 56C = 26.1K
Rset = 3 * 7.8K = 23.4K ==> 23.7K
Rhyst = (23.4K * 26.1K) / (3 * 26.1K - 23.4K) = 11.12K ==> 11.3K





Active point = 71.52W
Recovery point = 62.62W

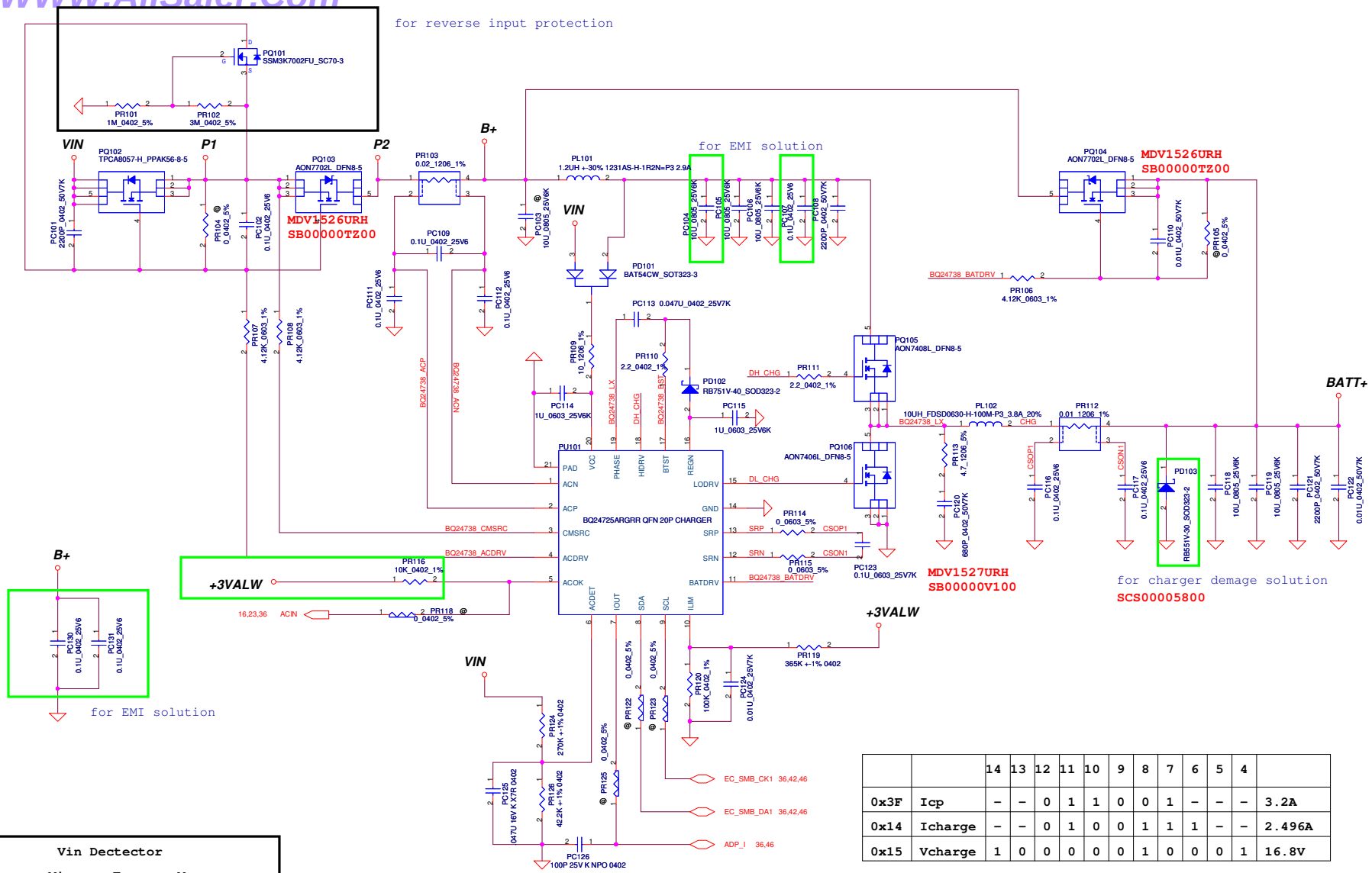
Security Classification	Compal Secret Data		
Issued Date	2011/10/03	Deciphered Date	2014/12/31

Compal Electronics, Inc.

Title: PWR- BATTERY CONN

Size	Document Number	Rev
Custom	LA-8551P	0.1

Date: Saturday, March 03, 2012 Sheet 46 of 59



		14	13	12	11	10	9	8	7	6	5	4	
0x3F	Icp	-	-	0	1	1	0	0	1	-	-	-	3.2A
0x14	Icharge	-	-	0	1	0	0	1	1	1	-	-	2.496A
0x15	Vcharge	1	0	0	0	0	0	1	0	0	0	1	16.8V

Vin Dectector

	Min.	Typ.	Max.
L-->H	17.45V	17.92V	18.42V
H-->L	16.89V	17.52V	18.16V

ILIM and external DPM
3.54A

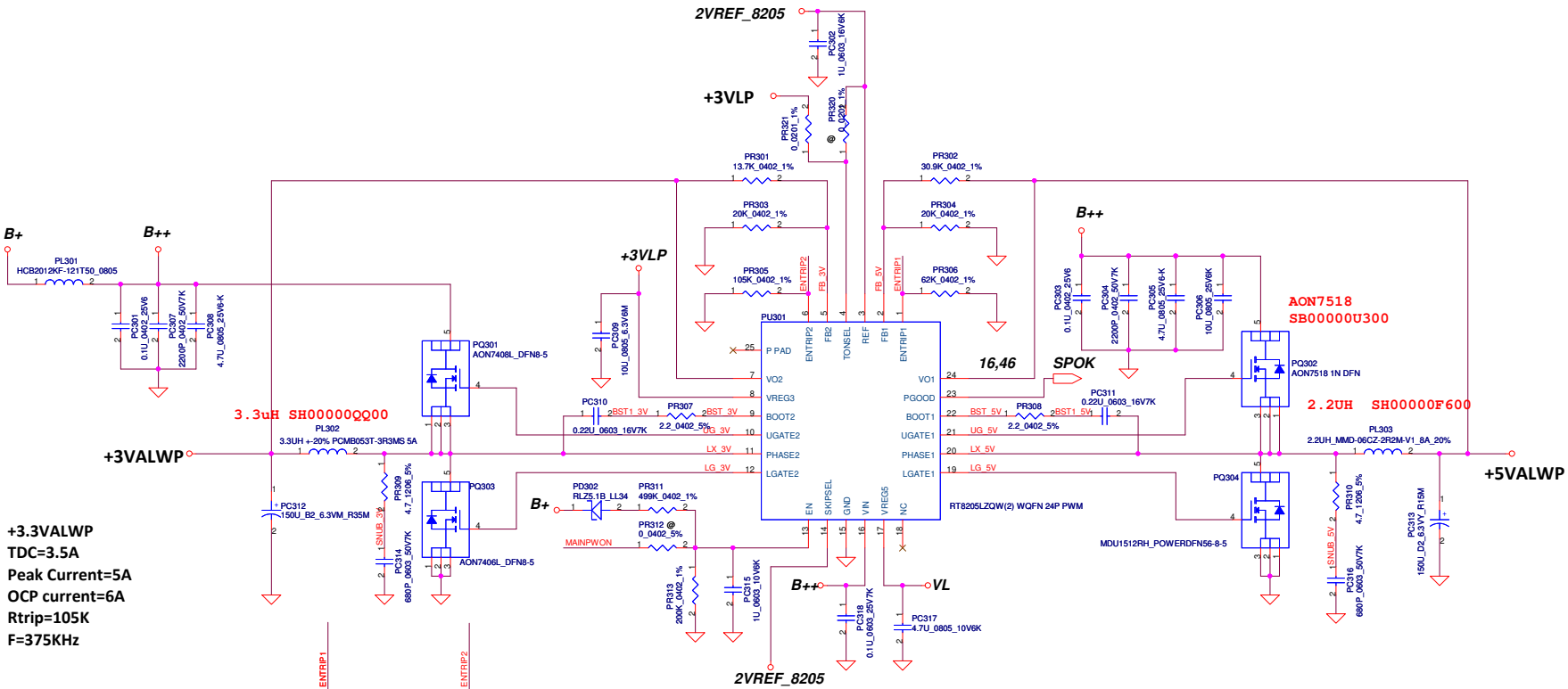
Security Classification	Compal Secret Data		
Issued Date	2011/10/03	Deciphered Date	2014/12/31

Compal Electronics, Inc.

Title: PWR- CHARGER

Size	Document Number	Rev
	LA-8551P	0.1

Date: Saturday, March 03, 2012 | Sheet 47 of 59



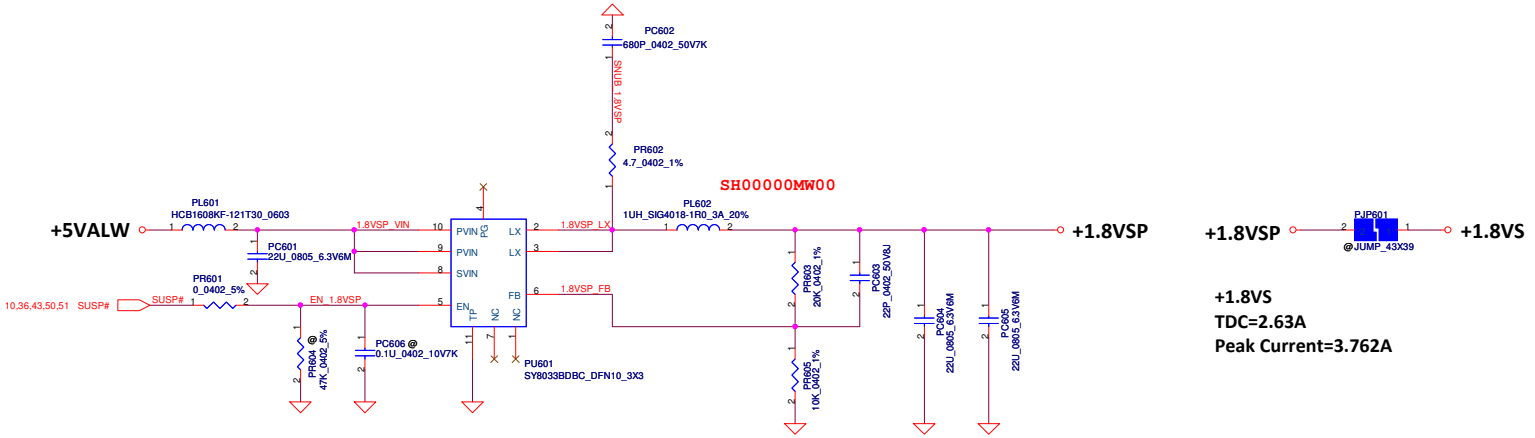
Security Classification	Compal Secret Data		
Issued Date	2011/10/03	Deciphered Date	2014/12/31

Compal Electronics, Inc.

Title: PWR- 3VALWP/5VALWP

Size	Document Number	Rev
Custom	LA-8551P	0.1

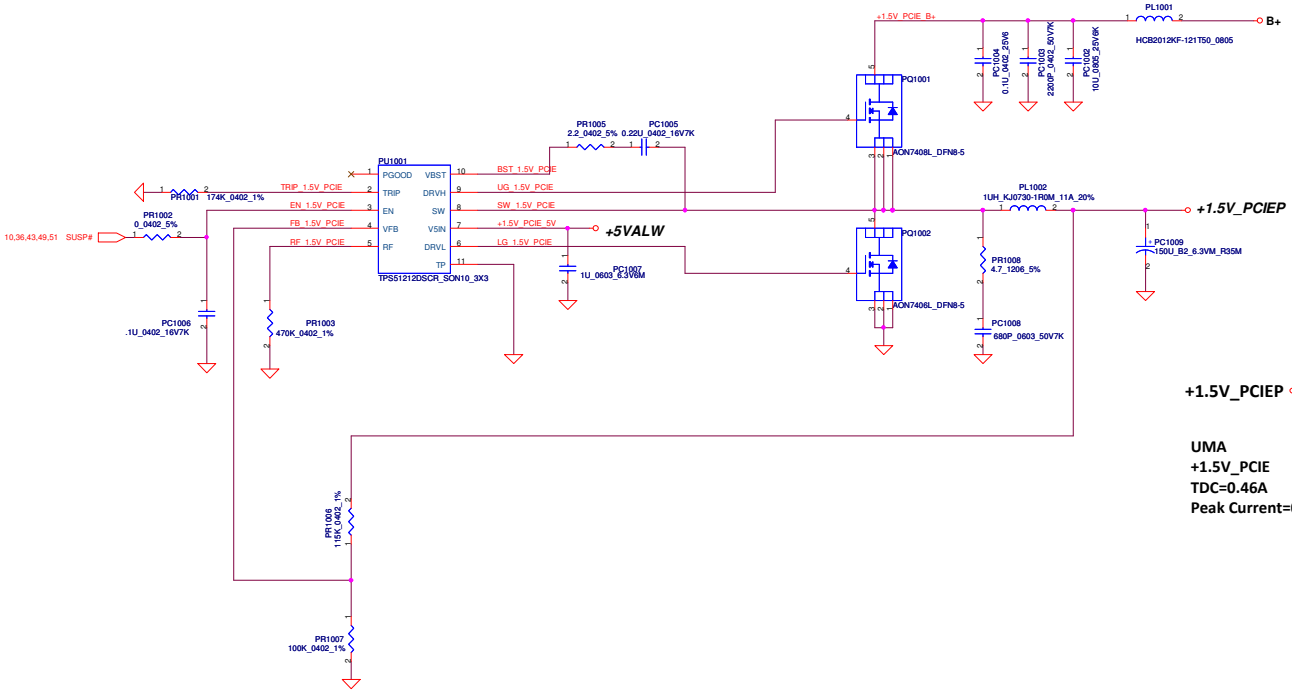
Date: Saturday, March 03, 2012 Sheet 48 of 59



+1.8VS
TDC=2.63A
Peak Current=3.762A

Security Classification	Compal Secret Data		
Issued Date	2011/10/03	Deciphered Date	2014/12/31

Compal Electronics, Inc.			
Title: PWR- 1.8VS			
Size	Document Number: LA-8551P		Rev: 0.1
Date: Saturday, March 03, 2012		Sheet 49 of 59	



+1.5V_PCIEP — PJP1001 JUMP_43X118 — +1.5V_PCIE

UMA	DIS
+1.5V_PCIE	+1.5V_PCIE
TDC=0.46A	TDC=6A
Peak Current=0.66A	Peak Current=8A

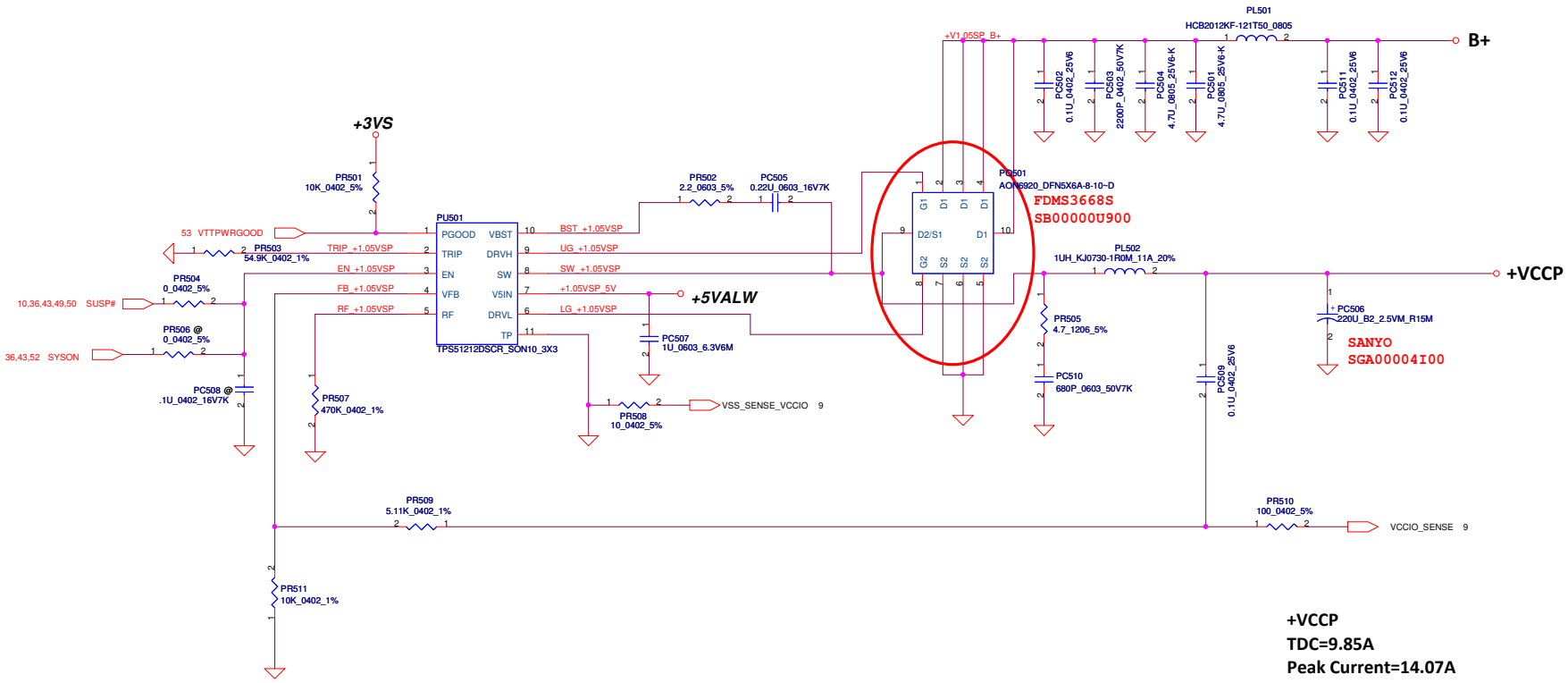
Security Classification	Compal Secret Data		
Issued Date	2011/10/03	Deciphered Date	2014/12/31

Compal Electronics, Inc.

Title: PWR- VGA_VDDC

Size: C | Document Number: LA-8551P | Rev: 0.1

Date: Saturday, March 03, 2012 | Sheet 50 of 59

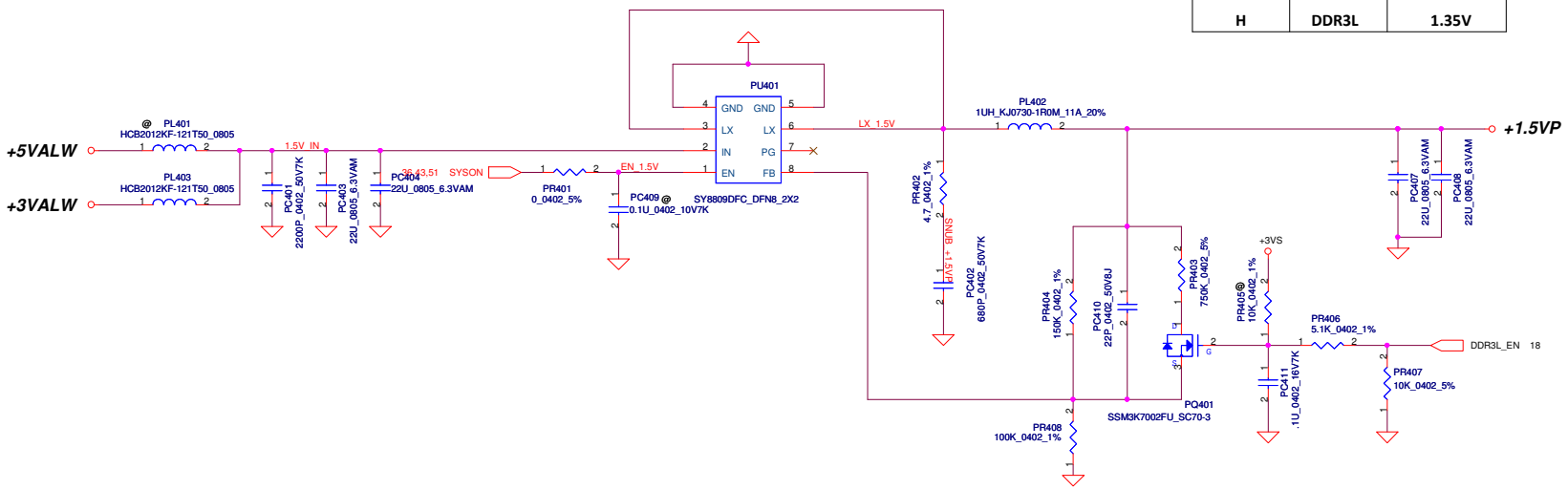


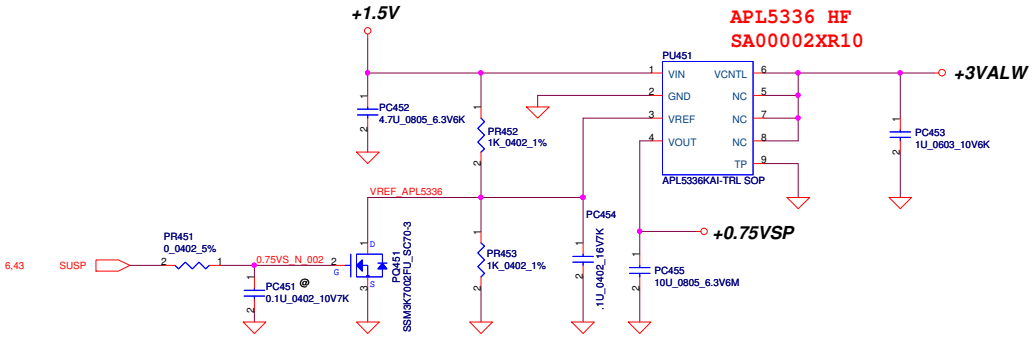
+VCCP
TDC=9.85A
Peak Current=14.07A
OCP current=16.88A
Rtrip = 54.9K

Security Classification	Compal Secret Data		
Issued Date	2011/10/03	Deciphered Date	2014/12/31

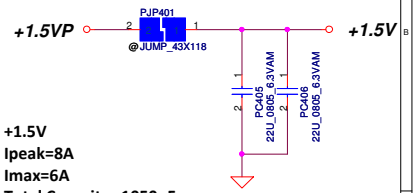
Compal Electronics, Inc.			
Title	PWR- VCCP		
Size: Custom	Document Number: LA-8551P		Rev: 0.1
Date: Saturday, March 03, 2012	Sheet 51 of 59		

DDR3L_EN		1.5VP
L	DDR3	1.5V
H	DDR3L	1.35V





+0.75VSP
TDC=1.4A
Peak Current=2A



+1.5V
Ipeak=8A
Imax=6A
Total Capacitor 1050uF,
ESR 4.43mohm

HW side:
C106 330uF 17m
C218 390uF 10m
VGA@ CV122 390uF 10m
@ C189 330uF 15m

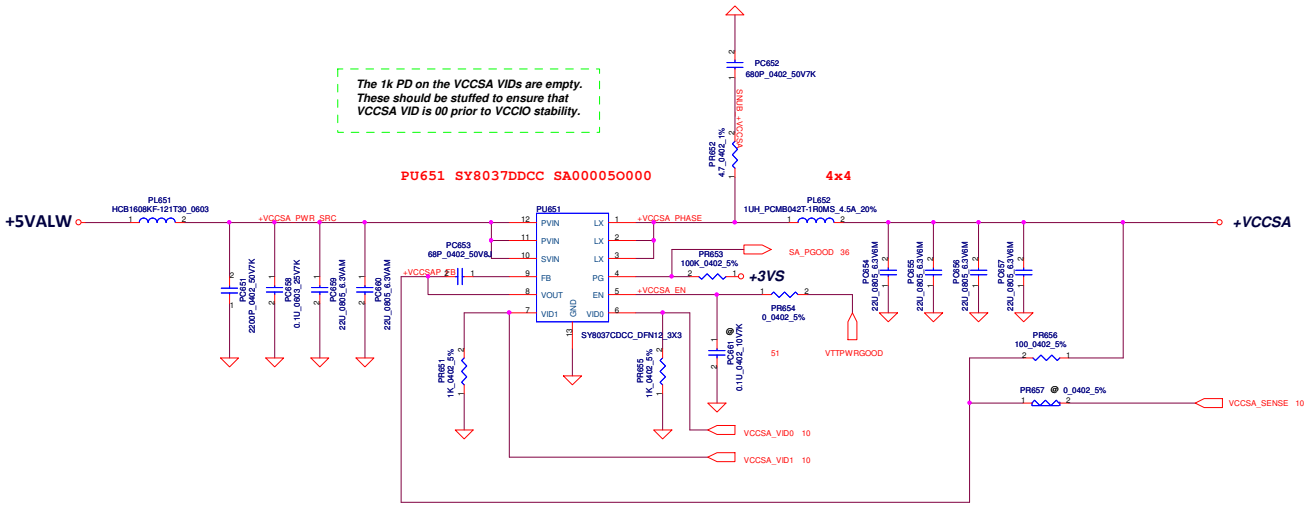
Security Classification	Compal Secret Data		
Issued Date	2011/10/03	Deciphered Date	2014/12/31

Compal Electronics, Inc.

Title: PWR- 1.5VP/0.75VSP

Size	Document Number	Rev
Custom	LA-8551P	0.1

Date: Saturday, March 03, 2012 Sheet 52 of 59

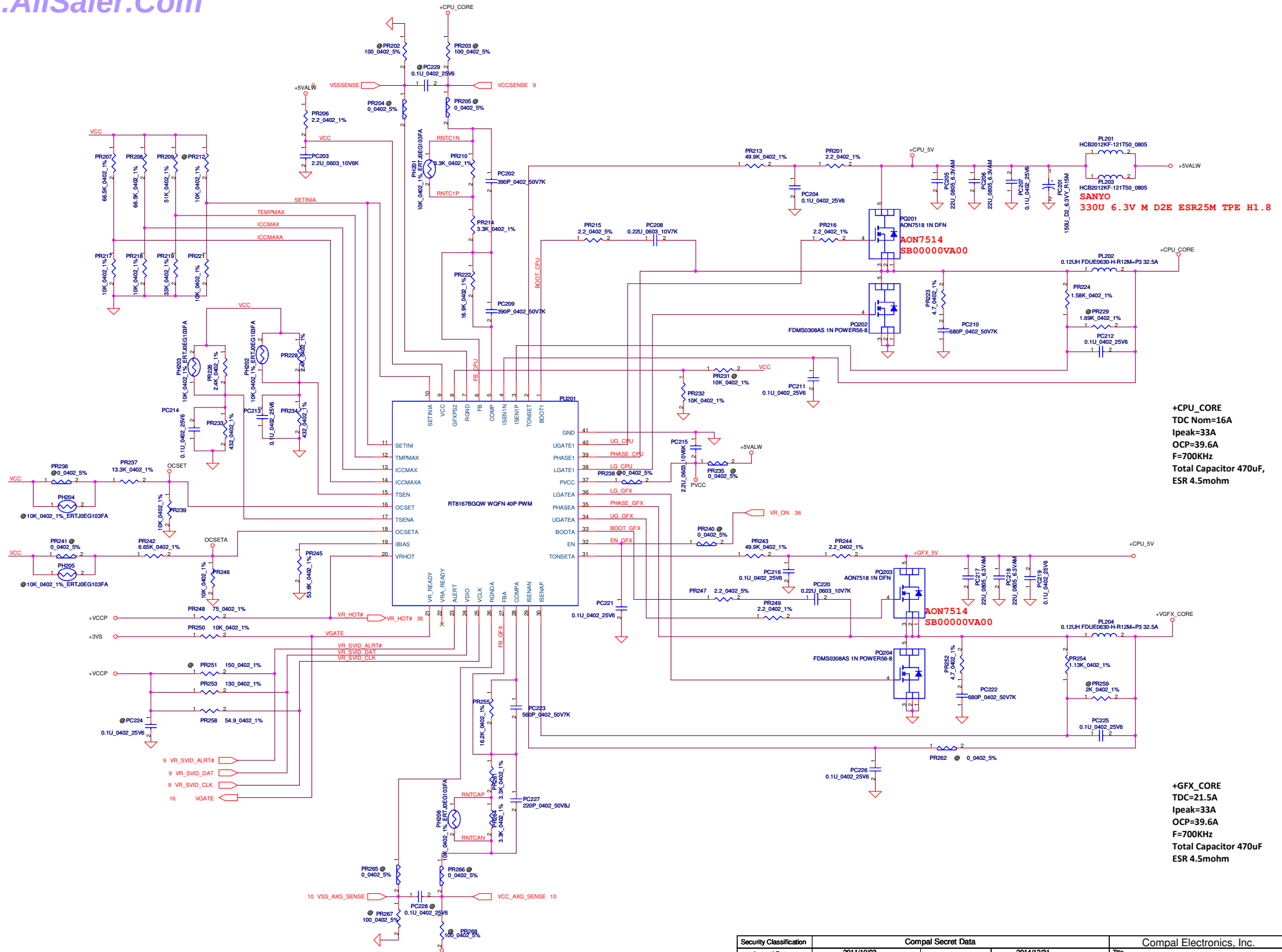


+VCCSA
Itdc=3A
Imax=4A

Security Classification	Compal Secret Data		
Issued Date	2011/10/03	Deciphered Date	2014/12/31

Compal Electronics, Inc.			
Title	PWR- VCCSA		
Size C	Document Number LA-8551P		Rev 0.1
Date: Saturday, March 03, 2012	Sheet 53 of 59		

QCL70



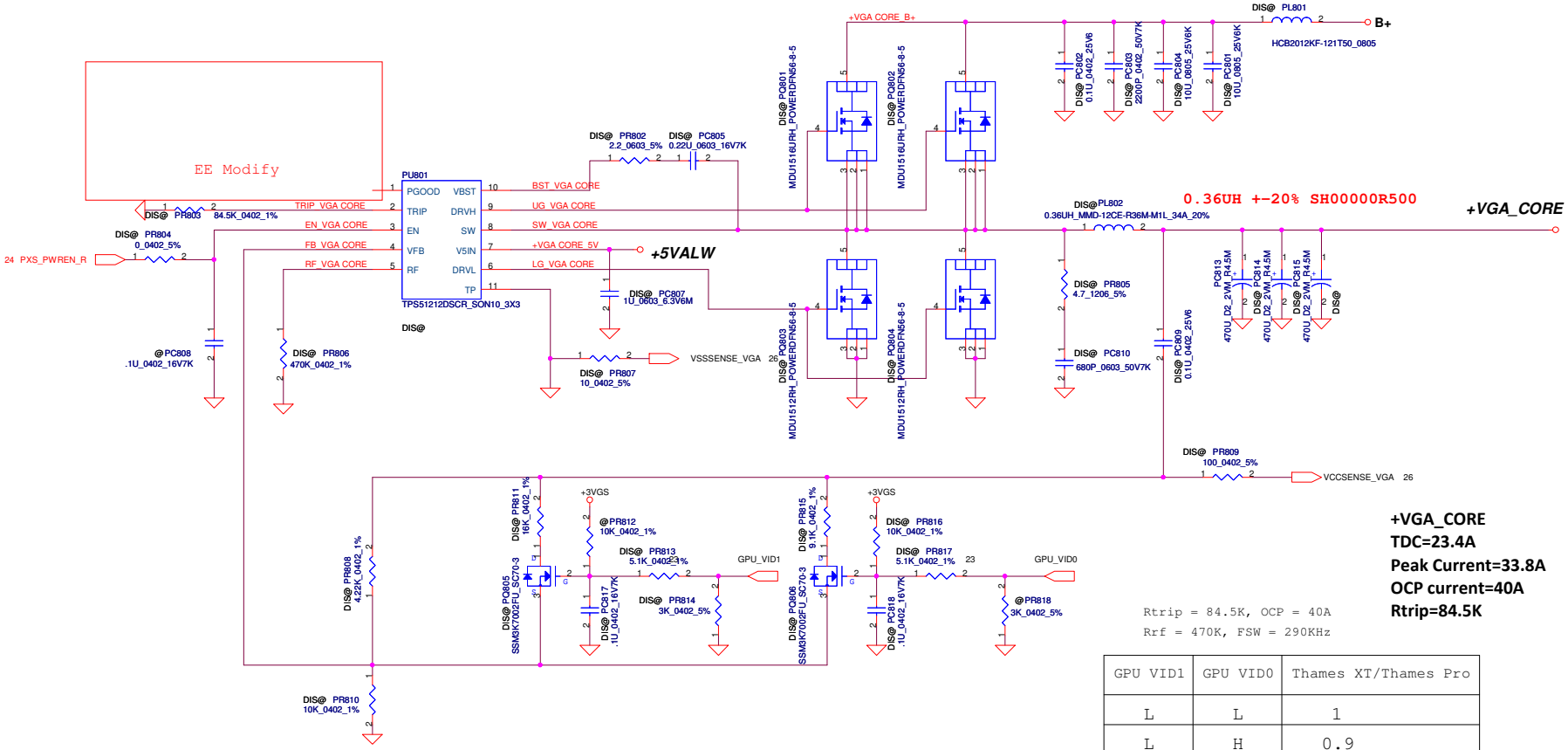
Security Classification	Compal Secret Data		
Issued Date	2011/10/03	Deciphered Date	2014/12/31

Compal Electronics, Inc.

Title: PWR- CPU GFX CORE

Size	Document Number	Rev
A2	LA-8551P	0.1

Date: Saturday, March 03, 2012 Sheet 54 of 59



+VGA_CORE
TDC=23.4A
Peak Current=33.8A
OCP current=40A
Rtrip=84.5K

Rtrip = 84.5K, OCP = 40A
Rrf = 470K, FSW = 290KHz

GPU VID1	GPU VID0	Thames XT/Thames Pro
L	L	1
L	H	0.9
H	L	0.94
H	H	0.875

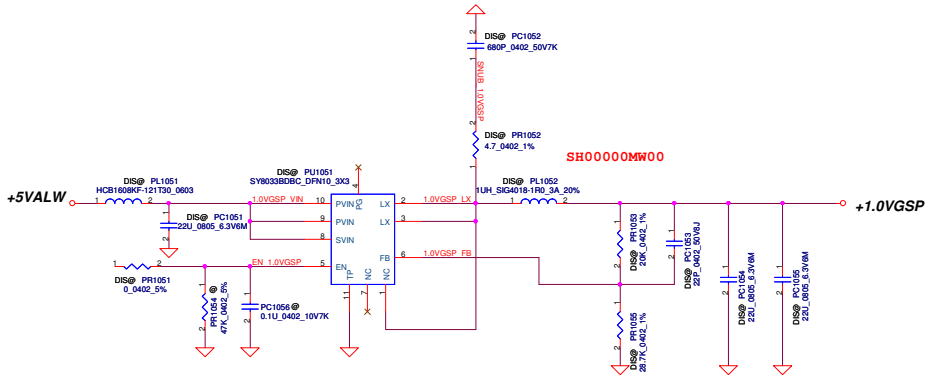
Security Classification	Compal Secret Data		
Issued Date	2011/10/03	Deciphered Date	2014/12/31

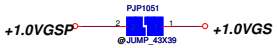
Compal Electronics, Inc.

Title: PWR- VGA_VDDC

Size: Custom | Document Number: LA-8551P | Rev: 0.1

Date: Wednesday, March 07, 2012 | Sheet 55 of 59





+1.0VSP
TDC=1.54A
Peak Current=2.2A

Security Classification	Compal Secret Data		
Issued Date	2011/10/03	Deciphered Date	2014/12/31

Compal Electronics, Inc.

Title: **PWR- VGA 1.0VGSP**

Size	Document Number	Rev
C	LA-8551P	0.1

Date: Monday, March 05, 2012 Sheet 56 of 59

+CPU_CORE

+CPU_CORE

PC1101 470U_D2_2VM_R4.5M

PC1104 22U_0805_6.3V6M
PC1105 22U_0805_6.3V6M
PC1106 22U_0805_6.3V6M
PC1107 22U_0805_6.3V6M
PC1108 22U_0805_6.3V6M
PC1109 22U_0805_6.3V6M
PC1110 22U_0805_6.3V6M
PC1111 22U_0805_6.3V6M
PC1112 22U_0805_6.3V6M
PC1113 22U_0805_6.3V6M
PC1114 22U_0805_6.3V6M
PC1115 22U_0805_6.3V6M

PC1118 2.2U_0402_6.3V6M
PC1119 2.2U_0402_6.3V6M
PC1120 2.2U_0402_6.3V6M
PC1121 2.2U_0402_6.3V6M
PC1122 2.2U_0402_6.3V6M
PC1123 2.2U_0402_6.3V6M
PC1124 2.2U_0402_6.3V6M
PC1125 2.2U_0402_6.3V6M

PC1136 2.2U_0402_6.3V6M
PC1137 2.2U_0402_6.3V6M
PC1138 2.2U_0402_6.3V6M
PC1139 2.2U_0402_6.3V6M
PC1140 2.2U_0402_6.3V6M
PC1141 2.2U_0402_6.3V6M
PC1142 2.2U_0402_6.3V6M
PC1143 2.2U_0402_6.3V6M

+VCCP

+VCCP

PC1116 330U_D2_2V_Y
PC1117 330U_D2_2V_Y

PC1126 10U_0603_6.3V6M
PC1127 10U_0603_6.3V6M
PC1128 10U_0603_6.3V6M
PC1129 10U_0603_6.3V6M
PC1130 10U_0603_6.3V6M
PC1131 10U_0603_6.3V6M
PC1132 10U_0603_6.3V6M
PC1133 10U_0603_6.3V6M
PC1134 10U_0603_6.3V6M
PC1135 10U_0603_6.3V6M

PC1144 1U_0402_6.3V6K
PC1145 1U_0402_6.3V6K
PC1146 1U_0402_6.3V6K
PC1147 1U_0402_6.3V6K
PC1148 1U_0402_6.3V6K
PC1149 1U_0402_6.3V6K
PC1150 1U_0402_6.3V6K
PC1151 1U_0402_6.3V6K
PC1152 1U_0402_6.3V6K
PC1153 1U_0402_6.3V6K

PC1156 1U_0402_6.3V6K
PC1157 1U_0402_6.3V6K
PC1158 1U_0402_6.3V6K
PC1159 1U_0402_6.3V6K
PC1160 1U_0402_6.3V6K
PC1161 1U_0402_6.3V6K
PC1162 1U_0402_6.3V6K
PC1163 1U_0402_6.3V6K
PC1164 1U_0402_6.3V6K
PC1165 1U_0402_6.3V6K

PC1172 1U_0402_6.3V6K
PC1173 1U_0402_6.3V6K
PC1174 1U_0402_6.3V6K
PC1175 1U_0402_6.3V6K
PC1176 1U_0402_6.3V6K
PC1177 1U_0402_6.3V6K

+VGFX_CORE

VGFX_CORE

PC1154 470U_D2_2VM_R4.5M

PC1166 22U_0805_6.3V6M
PC1167 22U_0805_6.3V6M
PC1168 22U_0805_6.3V6M
PC1169 22U_0805_6.3V6M
PC1170 22U_0805_6.3V6M
PC1171 22U_0805_6.3V6M

PC1178 10U_0603_10V6M
PC1179 10U_0603_10V6M
PC1180 10U_0603_6.3V6M
PC1181 10U_0603_6.3V6M
PC1182 10U_0603_6.3V6M
PC1183 10U_0603_6.3V6M

PC1184 1U_0402_6.3V6K
PC1185 1U_0402_6.3V6K
PC1186 1U_0402_6.3V6K
PC1187 1U_0402_6.3V6K
PC1188 1U_0402_6.3V6K
PC1189 1U_0402_6.3V6K
PC1190 1U_0402_6.3V6K
PC1191 1U_0402_6.3V6K
PC1192 1U_0402_6.3V6K
PC1193 1U_0402_6.3V6K
PC1194 1U_0402_6.3V6K

Security Classification	Compal Secret Data		
Issued Date	2011/10/03	Deciphered Date	2014/12/31

Compal Electronics, Inc.

Title: PWR - PROCESSOR DECOUPLING

Size	Document Number	Rev
	LA-8551P	0.1

Date: Saturday, March 03, 2012 Sheet 57 of 59

Version Change List (P. I. R. List)

Item	Page#	Title	Date	Request Owner	Issue Description	Solution Description	Rev.
1	47	change PC111 to 0402	2011/11/28		For layout space		
2	47	remove PR121	2011/11/28		0ohm, not needed		
3	47	change PR124 to 270K, PR126 to 42.2K	2011/11/28		change Vin detector setting		
4	47	change PC125 to 0.047uF	2011/11/28				
5	47	change PR125 to 0ohm, PC126 to 100pF	2011/11/28		FAE review recommand		
6	47	change PR119 to 365K	2011/11/28		modify charge Ilimit to 3.54A		
7	47	change PR111 to 0ohm	2011/11/28				
8	47	add PL101	2011/11/28				
9	46	delete PD5, PD6	2011/11/28		imbedded battery, ESD diode is not needed		
10	46	SMC, SMD exchange	2011/11/28				
11	46	delete pin8 and pin5, add battery temp sense at pin5.	2011/11/28		EC request to need one detect pin if SMB communication fail.		
12	47	change PQ302 to AON7518	2011/11/28				
13	50, 52	change PU1001, PU401 from SY8036HDBC to SY8036LDBC	2011/11/28				
14	53	change PU651 from SY8037DCC to SY8037ADCC	2011/11/28				
15	52	add PQ401, PR406, PR407, PC411	2011/11/28				
16	56	change PR1055 to 28.7K	2011/11/28		for correct 1.0V voltage		
17	54	change PL202, PL204 to SH00000PP00, 0.12uH	2011/11/28				
18	54	change PU201 to RT8167, SA00005AU00	2011/11/28				
19	54	change PQ201, PQ203 to AON7518, SB00000U300	2011/11/28				
20	54	change PQ202, PQ204 to FDMS0308AS, SB00000U400	2011/11/28				
21	55	change PL802 to 0.36uH, SH00000HD00	2011/11/28				
22	52	change PU401 to SY8809DFC	2011/11/29				
23	45, 48	change PD2, PD301 DIO CD4148WN-1 1206	2011/11/29		For cost and layout space		
24	51	add PC511, PC512	2011/12/11				
25	54	change PL201 to 0805, and add PL203	2011/12/11				
26	48	add PR320	2011/12/11		tune frequency		
27	55	change PC813, PC814, PC815, PC816 tp 330uF 9m	2011/12/11				
28	47	change PQ101 to SB000009610	2011/12/11				
29	54	change PR210, PR214, PR261, PR264 to 3.3K; PR222 to 15.8K; PR255 to 10.5K; PC202, PC209 to 270p; PC223 to 220p; PC227 to 560p; PR224, PR254 to 1.82K; PR207 to 127K	2011/12/11		Fine tune CPU, GFX transient		
30	47, 54	change PR111, PR110, PR216, PR249 to 2.2 ohm	2011/12/12		For EMI solution		
31	53, 56	change PL602, PL1052 to SH00000MW00	2011/12/12		For crack issue		
32	55	change PL802 to SH00000HQ00	2011/12/12		For thermal solution		
33	48	change PL303 to SH00000ON00	2011/12/12		For thermal solution		
34	47	change PR114, PR115 to 0 ohm	2011/12/14		Prevent charger damaged by negative output voltage		
35	54	change PR207 to 66.5K	2011/12/14		For GFX GT2 current limit		
36	54	change PR237 to 23.7K +-1% 0402	2011/12/23				
37	54	change PR241 to 1/16W 0 +-5% 0402	2011/12/23				
38	54	change PR242 to 23.7K +-1% 0402	2011/12/23				
39	47	change PQ103, PQ104 to SB00000TZ00	2011/12/23				
40	47, 48	change PQ106, PQ303 to SB00000H700	2011/12/23				
41	54	change PR210,PR261,PR264 to 3.3K +-1% 0402	2011/12/23				
42	53	change PL651 to SY8037CDCC	2012/1/11		For latch mode		
43	57	change PC1180, PC1181, PC1182, PC1183 to SE000005T80	2012/1/11		For height limit		
44	46	Delete PC11	2012/1/12		For ME request		

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Version Change List (P. I. R. List)

Item	Page#	Title	Date	Request Owner	Issue Description	Solution Description	Rev.
45	47	change PR114 to 10, PR115 to 6.8ohm, add PD103	2012/1/30		For Charger issue		
46	47	Add PC130, PC131, PC104, PC107	2012/1/30		For EMI solution		
47	48	Add PR321	2012/1/30		Choose working frequency to improve efficiency and thermal		
48	50	change 1.5VPCIE Circuit	2012/1/30		Change input voltage form 5V to 19V to slove thermal issue		
49	52	Add PL403	2012/1/30		Choose input voltage to slove thermal issue		
50	54	Change PR224 to1.58Kohm, PC209 to 220PF, PC202 to 390PF, PR222 to 16.9Kohm, PR237 to 21.5K	2012/1/30		Base on SI layout, FAE review recommand value		
51	48	change PL303 to SH00000F600	2012/1/30		For thermal issue		
52	45	Delete PD2, PR2, PR3, PC6	2012/1/30		For Layout space		
53	47, 48, 54	Change PQ302, PQ201, PQ203 to AON7514	2012/1/30		For efficiency		
54	51	Delete PJP501	2012/1/30		For Layout space		
55	55	Change PC813, PC814, PC815 to 470uF, delete PC816 Change PL802 0.36uF to 13*13*3.5 size	2012/1/30		For thermal issue		
56	55	Add PC820, PC821, PC822	2012/1/30		For VGA transient voltage		
57	57	Change PC1180, PC1181, PC1182, PC1183 to SE000005T80	2012/1/30		For ME request		
58	47	change PQ102 to TPCA8057	2012/1/30				
59	54	change PC223 to 560pF, PC227 to 220pF	2012/2/17		For FAE suggesstion		
60	48	change PQ302 to AON7518	2012/2/17		For efficiency		
61	55	change PL802 to 13*13*3 size	2012/2/17		For thermal solution		
62	47	change PR114, PR115 to 0 ohm, PD103 to SCS00005800	2012/2/17		For HP and soucer request		
63	54	change PC201 to 330uF	2012/2/17		For acoustic solution		
64	45	change LED circuit	2012/2/23				
65	48	change PL303 to 3.3uH 10*10*3H, PC313 to 150U_B2_6.3VM_R35M, remove 5V output jumper	2012/2/23		For thermal solution		
66	53	change PU651 to SY8037DDCC	2012/2/23		For ULV CPU and latch mode		
67	55	change PR812 and PR816 power to +3VGS	2012/2/23		For leakage issue		
68	45	change LED circuit	2012/2/29				
69	54	change PC209 to 390pF, PR237 to 13.3Kohm, PR254 to 1.13Kohm, PR255 to 16.2Kohm, PR242 to 6.65Kohm	2012/2/29		Base on PV layout		
70	45	change PL1, PL2 to 0603 size, add PL4	2012/2/29		EMI request		

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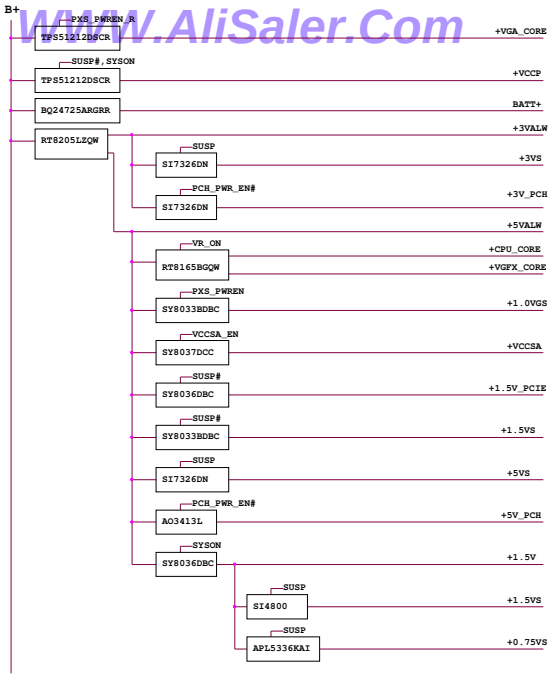

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